## This is a Divisonal of USSN 09/113,086 filed July 10, 1998. "ARRANGEMENT OF INK IN A LOW-COST DISPOSABLE CAMERA"

### Field of the Invention

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The present invention relates substantially to the concept of a disposable camera having instant printing capabilities and in particular, discloses a method integrating the electronic components of a camera system.

### **Background of the Invention**

Recently, the concept of a "single use" disposable camera has become an increasingly popular consumer item. Disposable camera systems presently on the market normally include an internal film roll and a simplified gearing mechanism for traversing the film roll across an imaging system including a shutter and lensing system. The user, after utilizing a single film roll returns the camera system to a film development center for processing. The film roll is taken out of the camera system and processed and the prints returned to the user. The camera system is then able to be re-manufactured through the insertion of a new film roll into the camera system, the replacement of any worn or wearable parts and the re-packaging of the camera system in accordance with requirements. In this way, the concept of a single use "disposable" camera is provided to the consumer.

Recently, a camera system has been proposed by the present applicant which provides for a handheld camera device having an internal print head, image sensor and processing means such that images sense by the image sensing means, are processed by the processing means and adapted to be instantly printed out by the printing means on demand. The proposed camera system further discloses a system of internal "print rolls" carrying print media such as film on to which images are to be printed in addition to ink for supplying to the printing means for the printing process. The print roll is further disclosed to be detachable and replaceable within the camera system.

Unfortunately, such a system is likely to only be constructed at a substantial cost and it would be desirable to provide for a more inexpensive form of instant camera system which maintains a substantial number of the quality aspects of the aforementioned arrangement.

It would be further advantageous to provide for the effective interconnection of

the sub components of a camera system.

### **Summary of the Invention**

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According to the invention there is provided a recyclable, one-time use, print on demand, digital camera comprising:

a chassis carrying:-

an image sensor device for sensing an image;

a processing means for processing said sensed image;

a pagewidth print head for printing said sensed image;

an ink supply means for supplying ink to the print head;

a supply of print media on to which said sensed image is printed; and

a casing surrounding an encasing chassis so that the ink supply means is unable to be accessed without destruction of the casing.

The casing may comprise two shells, the shells being bonded together during one of a manufacturing process and a recycling process. The shells may, additionally, be clipped together.

The shells may be of a synthetic plastics material so that the casing is a recyclable.

The ink supply means may comprise an ink supply cartridge which defines a plurality of ink supply channels, each of which is in communication with the print head and each channel containing a different color ink, in use, for enabling full color printing to be effected.

The ink supply cartridge may include an inlet opening in communication with each channel via which said channel is refilled during recycling of the camera. The inlet openings may be closed off by means of a suitable plug.

Each channel may have a vent associated therewith, the vent being open during a refilling operation of the ink channel to allow egress of air from the channel and the vent being sealed after the refilling operation.

The seal may be a replaceable seal to be removed during the refilling operation and replaced by a new seal after completion of the refilling operation.

### **Brief Description of the Drawings**

Notwithstanding any other forms which may fall within the scope of the present invention, preferred forms of the invention will now be described, by way of example only, with reference to the accompanying drawings in which:

Fig. 1 illustrates a front perspective view of the assembled camera of the preferred embodiment;

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- Fig. 2 illustrates a rear perspective view, partly exploded, of the preferred embodiment;
  - Fig. 3 is a perspective view of the chassis of the preferred embodiment;
  - Fig. 4 is a perspective view of the chassis illustrating mounting of electric motors;
- Fig. 5 is an exploded perspective view of the ink supply mechanism of the preferred embodiment;
- Fig. 6 is a rear perspective view of the assembled form of the ink supply mechanism of the preferred embodiment;
- Fig. 7 is a front perspective view of the assembled form of the ink supply mechanism of the preferred embodiment;
  - Fig. 8 is an exploded perspective view of the platten unit of the preferred embodiment;
    - Fig. 9 is a perspective view of the assembled form of the platten unit;
    - Fig. 10 is also a perspective view of the assembled form of the platten unit;
- Fig. 11 is an exploded perspective view of the printhead recapping mechanism of the preferred embodiment;
  - Fig. 12 is a close up, exploded perspective view of the recapping mechanism of the preferred embodiment;
- Fig. 13 is an exploded perspective view of the ink supply cartridge of the preferred embodiment;
- Fig. 14 is a close up, perspective view, partly in section, of the internal portions of the ink supply cartridge in an assembled form;
- Fig. 15 is a schematic block diagram of one form of chip layer of the image capture and processing chip of the preferred embodiment;
- Fig. 16 is an exploded perspective view illustrating the assembly process of the preferred embodiment;
  - Fig. 17 illustrates a front exploded perspective view of the assembly process of the preferred embodiment;
- Fig. 18 illustrates a perspective view of the assembly process of the preferred embodiment;
  - Fig. 19 illustrates a perspective view of the assembly process of the preferred embodiment;
    - Fig. 20 is a perspective view illustrating the insertion of the platten unit in the

preferred embodiment;

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Fig. 21 illustrates the interconnection of the electrical components of the preferred embodiment;

Fig. 22 illustrates the process of assembling the preferred embodiment; and

Fig. 23 is a perspective view further illustrating the assembly process of the preferred embodiment.

### **Description of Preferred and Other Embodiments**

Turning initially simultaneously to Fig. 1 and Fig. 2 there are illustrated perspective views of an assembled camera constructed in accordance with the preferred embodiment with Fig. 1 showing a front perspective view and Fig. 2 showing a rear perspective view. The camera 1 includes a paper or plastic film jacket 2 which can include simplified instructions 3 for the operation of the camera system 1. The camera system 1 includes a first "take" button 4 which is depressed to capture an image. The captured image is output via output slot 6. A further copy of the image can be obtained through depressing a second "printer copy" button 7 whilst an LED light 5 is illuminated. The camera system also provides the usual viewfinder 8 in addition to a CCD image capture/lensing system 9.

The camera system 1 provides for a standard number of output prints after which the camera system 1 ceases to function. A prints left indicator slot 10 is provided to indicate the number of remaining prints. A refund scheme at the point of purchase is assumed to be operational for the return of used camera systems for recycling.

Turning now to Fig. 3, the assembly of the camera system is based around an internal chassis 12 which can be a plastic injection molded part. A pair of paper pinch rollers 28, 29 utilized for de-curling are snap fitted into corresponding frame holes eg. 26, 27.

As shown in Fig. 4, the chassis 12 includes a series of mutually opposed prongs e.g. 13, 14 into which is snapped fitted a series of electric motors 16, 17. The electric motors 16, 17 can be entirely standard with the motor 16 being of a stepper motor type. The motors 16,17 include cogs 19, 20 for driving a series of gear wheels. A first set of gear wheels is provided for controlling a paper cutter mechanism and a second set is provided for controlling print roll movement.

Turning next to Figs. 5 to 7, there is illustrated an ink supply mechanism 40

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utilized in the camera system. Fig. 5 illustrates a rear exploded perspective view, Fig. 6 illustrates a rear assembled perspective view and Fig. 7 illustrates a front assembled view. The ink supply mechanism 40 is based around an ink supply cartridge 42 which contains printer ink and a print head mechanism for printing out pictures on demand. The ink supply cartridge 42 includes a side aluminum strip 43 which is provided as a shear strip to assist in cutting images from a paper roll.

A dial mechanism 44 is provided for indicating the number of "prints left". The dial mechanism 44 is snap fitted through a corresponding mating portion 46 so as to be freely rotatable.

As shown in Fig. 6, the mechanism 40 includes a flexible PCB strip 47 which interconnects with the print head and provides for control of the print head. The interconnection between the Flex PCB strip and an image sensor and print head chip can be via Tape Automated Bonding (TAB) strips 51, 58. A molded aspherical lens and aperture shim 50 (Fig. 5) is also provided for imaging an image onto the surface of the image sensor chip normally located within cavity 53 and a light box module or hood 52 is provided for snap fitting over the cavity 53 so as to provide for proper light control. A series of decoupling capacitors e.g. 34 can also be provided. Further a plug 45 (Fig. 7) is provided for re-plugging ink holes after refilling. A series of guide prongs e.g. 55-57 are further provided for guiding the flexible PCB strip 47.

The ink supply mechanism 40 interacts with a platten unit 60 which guides print

media under a printhead located in the ink supply mechanism. Fig. 8 shows an exploded view of the platten unit 60, while Figs. 9 and 10 show assembled views of the platten unit. The platten unit 60 includes a first pinch roller 61 which is snap fitted to one side of a platten base 62. Attached to a second side of the platten base 62 is a cutting mechanism 63 which traverses the platen unit 60 by means of a rod 64 having a screw thread which is rotated by means of cogged wheel 65 which is also fitted to the platten base 62. The screw threaded rod 64 mounts a block 67 which includes a cutting wheel 68 fastened via a fastener 69. Also mounted to the block 67 is a counter actuator which includes a pawl. The pawl 71 acts to rotate the dial mechanism 44 of Fig. 6 upon the return traversal of the cutting wheel. As shown previously in Fig. 6, the dial mechanism 44 includes a cogged surface which interacts with pawl 71 thereby maintaining a count of the number of photographs by means of numbers embossed on the surface of dial mechanism 44. The

cutting mechanism 63 is inserted into the platten base 62 by means of a snap fit via clips

e.g. 74.

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The platen unit 60 includes an internal recapping mechanism 80 for recapping the printhead when not in use. The recapping mechanism 80 includes a sponge portion 81 and is operated via a solenoid coil so as to provide for recapping of the print head. In the preferred embodiment, there is provided an inexpensive form of printhead re-capping mechanism provided for incorporation into a handheld camera system so as to provide for printhead re-capping of an inkjet printhead.

Fig. 11 illustrates an exploded view of the recapping mechanism whilst Fig. 12 illustrates a close up of the end portion thereof. The re-capping mechanism 80 is structured around a solenoid including a 16 turn coil 75 which can comprise insulated wire. The coil 75 is turned around a first stationery solenoid arm 76 which is mounted on a bottom surface of the platen base 62 (Fig. 8) and includes a post portion 77 to magnify effectiveness of operation. The arm 76 can comprise a ferrous material.

A second moveable arm 78 of the solenoid actuator is also provided. The arm 78 is moveable and is also made of ferrous material. Mounted on the arm is a sponge portion surrounded by an elastomer strip 79. The elastomer strip 79 is of a generally arcuate cross-section and acts as a leaf spring against the surface of the printhead ink supply cartridge 42 (Fig. 5) so as to provide for a seal against the surface of the printhead ink supply cartridge 42. In the quiescent position an elastomer spring unit 87, 88 acts to resiliently deform the elastomer seal 79 against the surface of the ink supply unit 42.

When it is desired to operate the printhead unit, upon the insertion of paper, the solenoid coil 75 is activated so as to cause the arm 78 to move down to be adjacent to the end plate 76. The arm 78 is held against end plate 76 while the printhead is printing by means of a small "keeper current" in coil 75. Simulation results indicate that the keeper current can be significantly less than the actuation current. Subsequently, after photo printing, the paper is guillotined by the cutting mechanism 63 of Fig. 8 acting against aluminum strip 43, and rewound so as to clear the area of the re-capping mechanism 80. Subsequently, the current is turned off and springs 87, 88 return the arm 78 so that the elastomer seal is again resting against the printhead ink supply cartridge.

It can be seen that the preferred embodiment provides for a simple and inexpensive means of re-capping a printhead through the utilization of a solenoid type device having a long rectangular form. Further, the preferred embodiment utilizes minimal power in that currents are only required whilst the device is operational and

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additionally, only a low keeper current is required whilst the printhead is printing.

Turning next to Fig. 13 and 14, Fig. 13 illustrates an exploded perspective of the ink supply cartridge 42 whilst Fig. 14 illustrates a close up sectional view of a bottom of the ink supply cartridge with the printhead unit in place. The ink supply cartridge 42 is based around a pagewidth printhead 102 which comprises a long slither of silicon having a series of holes etched on the back surface for the supply of ink to a front surface of the silicon wafer for subsequent ejection via a micro electro-mechanical system. The form of ejection can be many different forms such as those set out in the tables below.

Of course, many other inkjet technologies, as referred to the attached tables below, can also be utilized when constructing a printhead unit 102. The fundamental requirement of the ink supply cartridge 42 is the supply of ink to a series of color channels etched through the back surface of the printhead 102. In the description of the preferred embodiment, it is assumed that a three color printing process is to be utilized so as to provide full color picture output. Hence, the print supply unit includes three ink supply reservoirs being a cyan reservoir 104, a magenta reservoir 105 and a yellow reservoir 106. Each of these reservoirs is required to store ink and includes a corresponding sponge type material 107 - 109 which assists in stabilizing ink within the corresponding ink channel and inhibiting the ink from sloshing back and forth when the printhead is utilized in a handheld camera system. The reservoirs 104, 105, 106 are formed through the mating of first exterior plastic piece 110 and a second base piece 111.

At a first end 118 of the base piece 111 a series of air inlet 113 - 115 are provided. Each air inlet leads to a corresponding winding channel which is hydrophobically treated so as to act as an ink repellent and therefore repel any ink that may flow along the air inlet channel. The air inlet channel further takes a convoluted path assisting in resisting any ink flow out of the chambers 104 - 106. An adhesive tape portion 117 is provided for sealing the channels within end portion 118.

At the top end, there is included a series of refill holes (not shown) for refilling corresponding ink supply chambers 104, 105, 106. A plug 121 is provided for sealing the refill holes.

Turning now to Fig. 14, there is illustrated a close up perspective view, partly in section through the ink supply cartridge 42 of Fig. 13 when formed as a unit. The ink supply cartridge includes the three color ink reservoirs 104, 105, 106 which supply ink to different portions of the back surface of printhead 102 which includes a series of apertures

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128 defined therein for carriage of the ink to the front surface.

The ink supply cartridge 42 includes two guide walls 124, 125 which separate the various ink chambers and are tapered into an end portion abutting the surface of the printhead 102. The guide walls 124, 125 are further mechanically supported by block portions e.g. 126 which are placed at regular intervals along the length of the ink supply unit. The block portions 126 have space at portions close to the back of printhead 102 for the flow of ink around the back surface thereof.

The ink supply unit is preferably formed from a multi-part plastic injection mold and the mold pieces e.g. 110, 111 (Fig. 13) snap together around the sponge pieces 107, 109. Subsequently, a syringe type device can be inserted in the ink refill holes and the ink reservoirs filled with ink with the air flowing out of the air outlets 113 - 115. Subsequently, the adhesive tape portion 117 and plug 121 are attached and the printhead tested for operation capabilities. Subsequently, the ink supply cartridge 42 can be readily removed for refilling by means of removing the ink supply cartridge, performing a washing cycle, and then utilizing the holes for the insertion of a refill syringe filled with ink for refilling the ink chamber before returning the ink supply cartridge 42 to a camera.

Turning now to Fig. 15, there is shown an example layout of the Image Capture and Processing Chip (ICP) 48.

The Image Capture and Processing Chip 48 provides most of the electronic functionality of the camera with the exception of the print head chip. The chip 48 is a highly integrated system. It combines CMOS image sensing, analog to digital conversion, digital image processing, DRAM storage, ROM, and miscellaneous control functions in a single chip.

The chip is estimated to be around 32 mm<sup>2</sup> using a leading edge 0.18 micron CMOS/DRAM/APS process. The chip size and cost can scale somewhat with Moore's law, but is dominated by a CMOS active pixel sensor array 201, so scaling is limited as the sensor pixels approach the diffraction limit.

The ICP 48 includes CMOS logic, a CMOS image sensor, DRAM, and analog circuitry. A very small amount of flash memory or other non-volatile memory is also preferably included for protection against reverse engineering.

Alternatively, the ICP can readily be divided into two chips: one for the CMOS imaging array, and the other for the remaining circuitry. The cost of this two chip solution should not be significantly different than the single chip ICP, as the extra cost of packaging and bond-pad area is somewhat cancelled by the reduced total wafer area

requiring the color filter fabrication steps.

The ICP preferably contains the following functions:

Function
1.5 megapixel image sensor
Analog Signal Processors
Image sensor column decoders
Image sensor row decoders
Analogue to Digital Conversion (ADC)
Column ADC's
Auto exposure
12 Mbits of DRAM
DRAM Address Generator
Color interpolator
Convolver
Color ALU
Halftone matrix ROM
Digital halftoning
Print head interface
8 bit CPU core
Program ROM
Flash memory
Scratchpad SRAM
Parallel interface (8 bit)
Motor drive transistors (5)
Clock PLL
JTAG test interface
Test circuits
Busses
Bond pads

The CPU, DRAM, Image sensor, ROM, Flash memory, Parallel interface, JTAG interface and ADC can be vendor supplied cores. The ICP is intended to run on 1.5V to

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minimize power consumption and allow convenient operation from two AA type battery cells.

Fig. 15 illustrates a layout of the ICP 48. The ICP 48 is dominated by the imaging array 201, which consumes around 80% of the chip area. The imaging array is a CMOS 4 transistor active pixel design with a resolution of  $1,500 \times 1,000$ . The array can be divided into the conventional configuration, with two green pixels, one red pixel, and one blue pixel in each pixel group. There are  $750 \times 500$  pixel groups in the imaging array.

The latest advances in the field of image sensing and CMOS image sensing in particular can be found in the October, 1997 issue of IEEE Transactions on Electron Devices and, in particular, pages 1689 to 1968. Further, a specific implementation similar to that disclosed in the present application is disclosed in Wong et al., "CMOS Active Pixel Image Sensors Fabricated Using a 1.8V, 0.25 µm CMOS Technology", IEDM 1996, page 915

The imaging array uses a 4 transistor active pixel design of a standard configuration. To minimize chip area and therefore cost, the image sensor pixels should be as small as feasible with the technology available. With a four transistor cell, the typical pixel size scales as 20 times the lithographic feature size. This allows a minimum pixel area of around 3.6  $\mu$ m  $\times$  3.6  $\mu$ m. However, the photosite must be substantially above the diffraction limit of the lens. It is also advantageous to have a square photosite, to maximize the margin over the diffraction limit in both horizontal and vertical directions. In this case, the photosite can be specified as 2.5  $\mu$ m  $\times$  2.5  $\mu$ m. The photosite can be a photogate, pinned photodiode, charge modulation device, or other sensor.

The four transistors are packed as an 'L' shape, rather than a rectangular region, to allow both the pixel and the photosite to be square. This reduces the transistor packing density slightly, increasing pixel size. However, the advantage in avoiding the diffraction limit is greater than the small decrease in packing density.

The transistors also have a gate length which is longer than the minimum for the process technology. These have been increased from a drawn length of 0.18 micron to a drawn length of 0.36 micron. This is to improve the transistor matching by making the variations in gate length represent a smaller proportion of the total gate length.

The extra gate length, and the 'L' shaped packing, mean that the transistors use more area than the minimum for the technology. Normally, around 8  $\mu m^2$  would be required for rectangular packing. Preferably, 9.75  $\mu m^2$  has been allowed for the

transistors.

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The total area for each pixel is  $16~\mu m^2$ , resulting from a pixel size of  $4~\mu m \times 4~\mu m$ . With a resolution of 1,500 x 1,000, the area of the imaging array 101 is 6,000  $\mu m \times 4,000~\mu m$ , or  $24~mm^2$ .

The presence of a color image sensor on the chip affects the process required in two major ways:

- The CMOS fabrication process should be optimised to minimize dark current

Color filters are required. These can be fabricated using dyed photosensitive polyimides, resulting in an added process complexity of three spin coatings, three photolithographic steps, three development steps, and three hardbakes.

There are 15,000 analog signal processors (ASPs) 205, one for each of the columns of the sensor. The ASPs amplify the signal, provide a dark current reference, sample and hold the signal, and suppress the fixed pattern noise (FPN).

There are 375 analog to digital converters 206, one for each four columns of the sensor array. These may be delta-sigma or successive approximation type ADC's. A row of low column ADC's are used to reduce the conversion speed required, and the amount of analog signal degradation incurred before the signal is converted to digital. This also eliminates the hot spot (affecting local dark current) and the substrate coupled noise that would occur if a single high speed ADC was used. Each ADC also has two four bit DAC's which trim the offset and scale of the ADC to further reduce FPN variations between columns. These DAC's are controlled by data stored in flash memory during chip testing.

The column select logic 204 is a 1:1500 decoder which enables the appropriate digital output of the ADCs onto the output bus. As each ADC is shared by four columns, the least significant two bits of the row select control 4 input analog multiplexors.

A row decoder 207 is a 1:1000 decoder which enables the appropriate row of the active pixel sensor array. This selects which of the 1000 rows of the imaging array is connected to analog signal processors. As the rows are always accessed in sequence, the row select logic can be implemented as a shift register.

An auto exposure system 208 adjusts the reference voltage of the ADC 205 in response to the maximum intensity sensed during the previous frame period. Data from the green pixels is passed through a digital peak detector. The peak value of the image

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frame period before capture (the reference frame) is provided to a digital to analogue converter (DAC), which generates the global reference voltage for the column ADCs. The peak detector is reset at the beginning of the reference frame. The minimum and maximum values of the three RGB color components are also collected for color correction.

The second largest section of the chip is consumed by a DRAM 210 used to hold the image. To store the 1,500 x 1,000 image from the sensor without compression, 1.5 Mbytes of DRAM 210 are required. This equals 12 Mbits, or slightly less than 5% of a 256 Mbit DRAM. The DRAM technology assumed is of the 256 Mbit generation implemented using 0.18µm CMOS.

Using a standard 8F cell, the area taken by the memory array is 3.11 mm<sup>2</sup>. When row decoders, column sensors, redundancy, and other factors are taken into account, the DRAM requires around 4 mm<sup>2</sup>.

This DRAM 210 can be mostly eliminated if analog storage of the image signal can be accurately maintained in the CMOS imaging array for the two seconds required to print the photo. However, digital storage of the image is preferable as it is maintained without degradation, is insensitive to noise, and allows copies of the photo to be printed considerably later.

A DRAM address generator 211 provides the write and read addresses to the DRAM 210. Under normal operation, the write address is determined by the order of the data read from the CMOS image sensor 201. This will typically be a simple raster format. However, the data can be read from the sensor 201 in any order, if matching write addresses to the DRAM are generated. The read order from the DRAM 210 will normally simply match the requirements of a color interpolator and the print head. As the cyan, magenta, and yellow rows of the print head are necessarily offset by a few pixels to allow space for nozzle actuators, the colors are not read from the DRAM simultaneously. However, there is plenty of time to read all of the data from the DRAM many times during the printing process. This capability is used to eliminate the need for FIFOs in the print head interface, thereby saving chip area. All three RGB image components can be read from the DRAM each time color data is required. This allows a color space converter to provide a more sophisticated conversion than a simple linear RGB to CMY conversion.

Also, to allow two dimensional filtering of the image data without requiring line buffers, data is re-read from the DRAM array.

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The address generator may also implement image effects in certain models of camera. For example, passport photos are generated by a manipulation of the read addresses to the DRAM. Also, image framing effects (where the central image is reduced), image warps, and kaleidoscopic effects can all be generated by manipulating the read addresses of the DRAM.

While the address generator 211 may be implemented with substantial complexity if effects are built into the standard chip, the chip area required for the address generator is small, as it consists only of address counters and a moderate amount of random logic.

A color interpolator 214 converts the interleaved pattern of red,  $2 \times$  green, and blue pixels into RGB pixels. It consists of three 8 bit adders and associated registers. The divisions are by either 2 (for green) or 4 (for red and blue) so they can be implemented as fixed shifts in the output connections of the adders.

A convolver 215 is provided as a sharpening filter which applies a small convolution kernel (5  $\times$  5) to the red, green, and blue planes of the image. The convolution kernel for the green plane is different from that of the red and blue planes, as green has twice as many samples. The sharpening filter has five functions:

- to improve the color interpolation from the linear interpolation provided by the color interpolator, to a close approximation of a sinc interpolation;
- to compensate for the image 'softening' which occurs during digitisation;
- to adjust the image sharpness to match average consumer preferences, which are typically for the image to be slightly sharper than reality. As the single use camera is intended as a consumer product, and not a professional photographic products, the processing can match the most popular settings, rather than the most accurate;
- to suppress the sharpening of high frequency (individual pixel) noise. The function is similar to the 'unsharp mask' process; and
- to antialias Image Warping.

These functions are all combined into a single convolution matrix. As the pixel rate is low (less than 1 Mpixel per second) the total number of multiplies required for the three color channels is 56 million multiplies per second. This can be provided by a single multiplier. Fifty bytes of coefficient ROM are also required.

A color ALU 113 combines the functions of color compensation and color space conversion into the one matrix multiplication, which is applied to every pixel of the frame. As with sharpening, the color correction should match the most popular settings,

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rather than the most accurate.

A color compensation circuit of the color ALU provides compensation for the lighting of the photo. The vast majority of photographs are substantially improved by a simple color compensation, which independently normalizes the contrast and brightness of the three color components.

A color look-up table (CLUT) 212 is provided for each color component. These are three separate 256 × 8 SRAMs, requiring a total of 6,144 bits. The CLUTs are used as part of the color correction process. They are also used for color special effects, such as stochastically selected "wild color" effects.

A color space conversion system of the color ALU converts from the RGB color space of the image sensor to the CMY color space of the printer. The simplest conversion is a 1's complement of the RGB data. However, this simple conversion assumes perfect linearity of both color spaces, and perfect dye spectra for both the color filters of the image sensor, and the ink dyes. At the other extreme is a tri-linear interpolation of a sampled three dimensional arbitrary transform table. This can effectively match any non-linearity or differences in either color space. Such a system is usually necessary to obtain good color space conversion when the print engine is a color electrophotographic

However, since the non-linearity of a halftoned ink jet output is very small, a simpler system can be used. A simple matrix multiply can provide excellent results. This requires nine multiplies and six additions per contone pixel. However, since the contone pixel rate is low (less than 1 Mpixel/sec) these operations can share a single multiplier and adder. The multiplier and adder are used in a color ALU which is shared with the color compensation function.

Digital halftoning can be performed as a dispersed dot ordered dither using a stochastic optimized dither cell. A halftone matrix ROM 216 is provided for storing dither cell coefficients. A dither cell size of 32 × 32 is adequate to ensure that the cell repeat cycle is not visible. The three colors – cyan, magenta, and yellow – are all dithered using the same cell, to ensure maximum co-positioning of the ink dots. This minimizes 'muddying' of the mid-tones which results from bleed of dyes from one dot to adjacent dots while still wet. The total ROM size required is 1 KByte, as the one ROM is shared by the halftoning units for each of the three colors.

The digital halftoning used is dispersed dot ordered dither with stochastic optimized dither matrix. While dithering does not produce an image quite as 'sharp' as

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error diffusion, it does produce a more accurate image with fewer artifacts. The image sharpening produced by error diffusion is artificial, and less controllable and accurate than 'unsharp mask' filtering performed in the contone domain. The high print resolution (1,600 dpi × 1,600 dpi) results in excellent quality when using a well formed stochastic dither matrix.

Digital halftoning is performed by a digital halftoning unit 217 using a simple comparison between the contone information from the DRAM 210 and the contents of the dither matrix 216. During the halftone process, the resolution of the image is changed from the 250 dpi of the captured contone image to the 1,600 dpi of the printed image. Each contone pixel is converted to an average of 40.96 halftone dots.

The ICP incorporates a 16 bit microcontroller CPU core 219 to run the miscellaneous camera functions, such as reading the buttons, controlling the motor and solenoids, setting up the hardware, and authenticating the refill station. The processing power required by the CPU is very modest, and a wide variety of processor cores can be used. As the entire CPU program is run from a small ROM 220 program compatibility between camera versions is not important, as no external programs are run. A 2 Mbit (256 Kbyte) program and data ROM 220 is included on chip. Most of this ROM space is allocated to data for outline graphics and fonts for specialty cameras. The program requirements are minor. The single most complex task is the encrypted authentication of the refill station. The ROM requires a single transistor per bit.

A Flash memory 221 may be used to store a 128 bit authentication code. This provides higher security than storage of the authentication code in ROM, as reverse engineering can be made essentially impossible. The Flash memory is completely covered by third level metal, making the data impossible to extract using scanning probe microscopes or electron beams. The authentication code is stored in the chip when manufactured. At least two other Flash bits are required for the authentication process: a bit which locks out reprogramming of the authentication code, and a bit which indicates that the camera has been refilled by an authenticated refill station. The flash memory can also be used to store FPN correction data for the imaging array. Additionally, a phase locked loop rescaling parameter is stored for scaling the clocking cycle to an appropriate correct time. The clock frequency does not require crystal accuracy since no date functions are provided. To eliminate the cost of a crystal, an on chip oscillator with a phase locked loop 224 is used. As the frequency of an on-chip oscillator is highly

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variable from chip to chip, the frequency ratio of the oscillator to the PLL is digitally trimmed during initial testing. The value is stored in Flash memory 221. This allows the clock PLL to control the ink-jet heater pulse width with sufficient accuracy.

A scratchpad SRAM is a small static RAM 222 with a 6T cell. The scratchpad provided temporary memory for the 16 bit CPU. 1024 bytes is adequate.

A print head interface 223 formats the data correctly for the print head. The print head interface also provides all of the timing signals required by the print head. These timing signals may vary depending upon temperature, the number of dots printed simultaneously, the print medium in the print roll, and the dye density of the ink in the print roll.

The following is a table of external connections to the print head interface:

Connection	Function	Pins
DataBits[0-7]	Independent serial data to the eight segments of the printhead	8
BitClock	Main data clock for the print head	1
ColorEnable[0-2]	Independent enable signals for the CMY actuators, allowing different pulse times for each color.	3
BankEnable[0-1]	Allows either simultaneous or interleaved actuation of two banks of nozzles. This allows two different print speed/power consumption tradeoffs	2
NozzleSelect[0-4]	Selects one of 32 banks of nozzles for simultaneous actuation	5
ParallelXferClock	Loads the parallel transfer register with the data from the shift registers	1
Total		20

The printhead utilized is composed of eight identical segments, each 1.25 cm long. There is no connection between the segments on the print head chip. Any connections required are made in the external TAB bonding film, which is double sided. The division into eight identical segments is to simplify lithography using wafer steppers. The segment width of 1.25 cm fits easily into a stepper field. As the printhead chip is long and narrow ( $10 \text{ cm} \times 0.3 \text{ mm}$ ), the stepper field contains a single segment of 32 print head chips. The stepper field is therefore 1.25 cm  $\times$  1.6 cm. An average of four complete print heads are patterned in each wafer step.

A single BitClock output line connects to all 8 segments on the printhead. The 8 DataBits lines lead one to each segment, and are clocked into the 8 segments on the print

IR23US

head simultaneously (on a BitClock pulse). For example, dot 0 is transferred to segment<sub>0</sub>, dot 750 is transferred to segment<sub>1</sub>, dot 1500 to segment<sub>2</sub> etc simultaneously.

The ParallelXferClock is connected to each of the 8 segments on the printhead, so that on a single pulse, all segments transfer their bits at the same time.

The NozzleSelect, BankEnable and ColorEnable lines are connected to each of the 8 segments, allowing the print head interface to independently control the duration of the cyan, magenta, and yellow nozzle energizing pulses. Registers in the Print Head Interface allow the accurate specification of the pulse duration between 0 and 6 ms, with a typical duration of 2 ms to 3 ms.

A parallel interface 125 connects the ICP to individual static electrical signals. The CPU is able to control each of these connections as memory mapped I/O via a low speed bus.

The following is a table of connections to the parallel interface:

Connection	Direction	Pins
Paper transport stepper motor	Output	4
Capping solenoid	Output	1
Copy LED	Output	1
Photo button	Input	1
Copy button	Input	1
Total		8

Seven high current drive transistors e.g. 227 are required. Four are for the four phases of the main stepper motor two are for the guillotine motor, and the remaining transistor is to drive the capping solenoid. These transistors are allocated 20,000 square microns (600,000 F) each. As the transistors are driving highly inductive loads, they must either be turned off slowly, or be provided with a high level of back EMF protection. If adequate back EMF protection cannot be provided using the chip process chosen, then external discrete transistors should be used. The transistors are never driven at the same time as the image sensor is used. This is to avoid voltage fluctuations and hot spots affecting the image quality. Further, the transistors are located as far away from the sensor as possible.

A standard JTAG (Joint Test Action Group) interface 228 is included in the ICP for testing purposes and for interrogation by the refill station. Due to the complexity of the chip, a variety of testing techniques are required, including BIST (Built In Self Test) and

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functional block isolation. An overhead of 10% in chip area is assumed for chip testing circuitry for the random logic portions. The overhead for the large arrays the image sensor and the DRAM is smaller.

The JTAG interface is also used for authentication of the refill station. This is included to ensure that the cameras are only refilled with quality paper and ink at a properly constructed refill station, thus preventing inferior quality refills from occurring. The camera must authenticate the refill station, rather than vice versa. The secure protocol is communicated to the refill station during the automated test procedure. Contact is made to four gold plated spots on the ICP/print head TAB by the refill station as the new ink is injected into the print head.

Fig. 16 illustrates a rear view of the next step in the construction process whilst Fig. 17 illustrates a front view.

Turning now to Fig. 16, the assembly of the camera system proceeds via first assembling the ink supply mechanism 40. The flex PCB is interconnected with batteries 84, only one of which is shown, which are inserted in the middle portion of a print roll 85 which is wrapped around a plastic former 86. An end cap 89 is provided at the other end of the print roll 85 so as to fasten the print roll and batteries firmly to the ink supply mechanism.

The solenoid coil is interconnected (not shown) to interconnects 97, 98 (Fig. 8) which include leaf spring ends for interconnection with electrical contacts on the Flex PCB so as to provide for electrical control of the solenoid.

Turning now to Figs. 17 - 19 the next step in the construction process is the insertion of the relevant gear trains into the side of the camera chassis. Fig. 17 illustrates a front view, Fig. 18 illustrates a rear view and Fig. 19 also illustrates a rear view. The first gear train comprising gear wheels 22, 23 is utilized for driving the guillotine blade with the gear wheel 23 engaging the gear wheel 65 of Fig. 8. The second gear train comprising gear wheels 24, 25 and 26 engage one end of the print roller 61 of Fig. 8. As best indicated in Fig. 18, the gear wheels mate with corresponding pins on the surface of the chassis with the gear wheel 26 being snap fitted into corresponding mating hole 27.

Next, as illustrated in Fig. 20, the assembled platten unit 60 is then inserted between the print roll 85 and aluminum cutting blade 43.

Turning now to Fig. 21, by way of illumination, there is illustrated the electrically interactive components of the camera system. As noted previously, the components are

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based around a Flex PCB board and include a TAB film 58 which interconnects the printhead 102 with the image sensor and processing chip 48. Power is supplied by two AA type batteries 83, 84 and a paper drive stepper motor 16 is provided in addition to a rotary guillotine motor 17.

An optical element 31 is provided for snapping into a top portion of the chassis 12. The optical element 31 includes portions defining an optical view finder 32, 33 which are slotted into mating portions 35, 36 in view finder channel 37. Also provided in the optical element 31 is a lensing system 38 for magnification of the prints left number in addition to an optical pipe element 39 for piping light from the LED 5 for external display.

Turning next to Fig. 22, the assembled unit 90 is then inserted into a front outer case 91 which includes button 4 for activation of printouts.

Turning now to Fig. 23, next, the unit 90 is provided with a snap-on back cover 93 which includes a slot 6 and copy print button 7. A wrapper label containing instructions and advertising (not shown) is then wrapped around the outer surface of the camera system and pinch clamped to the cover by means of clamp strip 96 which can comprise a flexible plastic or rubber strip.

Subsequently, the preferred embodiment is ready for use as a one time use camera system that provides for instant output images on demand. It will be evident that the preferred embodiment further provides for a refillable camera system. A used camera can be collected and its outer plastic cases removed and recycled. A new paper roll and batteries can be added and the ink cartridge refilled. A series of automatic test routines can then be carried out to ensure that the printer is properly operational. Further, in order to ensure only authorized refills are conducted so as to enhance quality, routines in the on-chip program ROM can be executed such that the camera authenticates the refilling station using a secure protocol. Upon authentication, the camera can reset an internal paper count and an external case can be fitted on the camera system with a new outer label. Subsequent packing and shipping can then take place.

It will be further readily evident to those skilled in the art that the program ROM can be modified so as to allow for a variety of digital processing routines. In addition to the digitally enhanced photographs optimized for mainstream consumer preferences, various other models can readily be provided through mere re-programming of the program ROM. For example, a sepia classic old fashion style output can be provided through a remapping of the color mapping function. A further alternative is to provide for

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black and white outputs again through a suitable color remapping algorithm. Minimum color can also be provided to add a touch of color to black and white prints to produce the effect that was traditionally used to colorize black and white photos. Further, passport photo output can be provided through suitable address remappings within the address generators. Further, edge filters can be utilized as is known in the field of image processing to produce sketched art styles. Further, classic wedding borders and designs can be placed around an output image in addition to the provision of relevant clip arts. For example, a wedding style camera might be provided. Further, a panoramic mode can be provided so as to output the well known panoramic format of images. Further, a postcard style output can be provided through the printing of postcards including postage on the back of a print roll surface. Further, cliparts can be provided for special events such as Halloween, Christmas etc. Further, kaleidoscopic effects can be provided through address remappings and wild color effects can be provided through remapping of the color lookup table. Many other forms of special event cameras can be provided for example, cameras dedicated to the Olympics, movie tie-ins, advertising and other special events.

The operational mode of the camera can be programmed so that upon the depressing of the take photo a first image is sampled by the sensor array to determine irrelevant parameters. Next a second image is again captured which is utilized for the output. The captured image is then manipulated in accordance with any special requirements before being initially output on the paper roll. The LED light is then activated for a predetermined time during which the DRAM is refreshed so as to retain the image. If the print copy button is depressed during this predetermined time interval, a further copy of the photo is output. After the predetermined time interval where no use of the camera has occurred, the onboard CPU shuts down all power to the camera system until such time as the take button is again activated. In this way, substantial power savings can be realized.

### Ink Jet Technologies

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The embodiments of the invention use an ink jet printer type device. Of course many different devices could be used. However presently popular ink jet printing technologies are unlikely to be suitable.

The most significant problem with thermal inkjet is power consumption. This is approximately 100 times that required for high speed, and stems from the energy-inefficient means of drop ejection. This involves the rapid boiling of water to produce a vapor bubble which expels the ink. Water has a very high heat capacity, and must be superheated in thermal inkjet applications. This leads to an efficiency of around 0.02%, from electricity input to drop momentum (and increased surface area) out.

The most significant problem with piezoelectric inkjet is size and cost. Piezoelectric crystals have a very small deflection at reasonable drive voltages, and therefore require a large area for each nozzle. Also, each piezoelectric actuator must be connected to its drive circuit on a separate substrate. This is not a significant problem at the current limit of around 300 nozzles per print head, but is a major impediment to the fabrication of pagewidth print heads with 19,200 nozzles.

Ideally, the inkjet technologies used meet the stringent requirements of in-camera digital color printing and other high quality, high speed, low cost printing applications. To meet the requirements of digital photography, new inkjet technologies have been created.

The target features include:

low power (less than 10 Watts) high resolution capability (1,600 dpi or more) photographic quality output

low manufacturing cost

small size (pagewidth times minimum cross section)

high speed (< 2 seconds per page).

All of these features can be met or exceeded by the inkjet systems described below with differing levels of difficulty. forty-five different inkjet technologies have been developed by the Assignee to give a wide range of choices for high volume manufacture. These technologies form part of separate applications assigned to the present Assignee as set out in the table below.

The inkjet designs shown here are suitable for a wide range of digital printing systems, from battery powered one-time use digital cameras, through to desktop and

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network printers, and through to commercial printing systems

For ease of manufacture using standard process equipment, the printhead is designed to be a monolithic 0.5 micron CMOS chip with MEMS post processing. For color photographic applications, the print head is 100 mm long, with a width which depends upon the inkjet type. The smallest print head designed is IJ38, which is 0.35 mm wide, giving a chip area of 35 square mm. The print heads each contain 19,200 nozzles plus data and control circuitry.

Ink is supplied to the back of the print head by injection molded plastic ink channels. The molding requires 50 micron features, which can be created using a lithographically micromachined insert in a standard injection molding tool. Ink flows through holes etched through the wafer to the nozzle chambers fabricated on the front surface of the wafer. The print head is connected to the camera circuitry by tape automated bonding.

### 15 <u>Cross-Referenced Applications</u>

The following table is a guide to cross-referenced patent applications filed concurrently herewith and discussed hereinafter with the reference being utilized in subsequent tables when referring to a particular case:

Docket	Reference	Title
No.		
IJ01US	IJ01	Radiant Plunger Ink Jet Printer
IJ02US	IJ02	Electrostatic Ink Jet Printer
IJ03US	IJ03	Planar Thermoelastic Bend Actuator Ink Jet
IJ04US	IJ04	Stacked Electrostatic Ink Jet Printer
IJ05US	IJ05	Reverse Spring Lever Ink Jet Printer
IJ06US	1J06	Paddle Type Ink Jet Printer
IJ07US	IJ07	Permanent Magnet Electromagnetic Ink Jet Printer
IJ08US	IJ08	Planar Swing Grill Electromagnetic Ink Jet Printer
IJ09US	IJ09	Pump Action Refill Ink Jet Printer
IJ10US	IJ10	Pulsed Magnetic Field Ink Jet Printer
IJ11US	IJ11	Two Plate Reverse Firing Electromagnetic Ink Jet Printer
IJ12US	IJ12	Linear Stepper Actuator Ink Jet Printer

IJ13US	IJ13	Gear Driven Shutter Ink Jet Printer
IJ14US	IJ14	Tapered Magnetic Pole Electromagnetic Ink Jet Printer
IJ15US	IJ15	Linear Spring Electromagnetic Grill Ink Jet Printer
IJ16US	IJ16	Lorenz Diaphragm Electromagnetic Ink Jet Printer
IJ17US	IJ17	PTFE Surface Shooting Shuttered Oscillating Pressure Ink Jet Printer
IJ18US	IJ18	Buckle Grip Oscillating Pressure Ink Jet Printer
IJ19US	IJ19	Shutter Based Ink Jet Printer
IJ20US	IJ20	Curling Calyx Thermoelastic Ink Jet Printer
IJ21US	IJ21	Thermal Actuated Ink Jet Printer
IJ22US	IJ22	Iris Motion Ink Jet Printer
IJ23US	IJ23	Direct Firing Thermal Bend Actuator Ink Jet Printer
IJ24US	IJ24	Conductive PTFE Ben Activator Vented Ink Jet Printer
IJ25US	IJ25	Magnetostrictive Ink Jet Printer
IJ26US	IJ26	Shape Memory Alloy Ink Jet Printer
IJ27US	IJ27	Buckle Plate Ink Jet Printer
IJ28US	IJ28	Thermal Elastic Rotary Impeller Ink Jet Printer
IJ29US	IJ29	Thermoelastic Bend Actuator Ink Jet Printer
IJ30US	IJ30	Thermoelastic Bend Actuator Using PTFE and Corrugated Copper
		Ink Jet Printer
IJ31US	IJ31	Bend Actuator Direct Ink Supply Ink Jet Printer
IJ32US	IJ32	A High Young's Modulus Thermoelastic Ink Jet Printer
IJ33US	IJ33	Thermally actuated slotted chamber wall ink jet printer
IJ34US	IJ34	Ink Jet Printer having a thermal actuator comprising an external
		coiled spring
IJ35US	IJ35	Trough Container Ink Jet Printer
IJ36US	IJ36	Dual Chamber Single Vertical Actuator Ink Jet
IJ37US	IJ37	Dual Nozzle Single Horizontal Fulcrum Actuator Ink Jet
IJ38US	IJ38	Dual Nozzle Single Horizontal Actuator Ink Jet
IJ39US	IJ39	A single bend actuator cupped paddle ink jet printing device
IJ40US	IJ40	A thermally actuated ink jet printer having a series of thermal
		actuator units
IJ41US	IJ41	A thermally actuated ink jet printer including a tapered heater

		element	
IJ42US	IJ42	Radial Back-Curling Thermoelastic Ink Jet	-
IJ43US	IJ43	Inverted Radial Back-Curling Thermoelastic Ink Jet	
IJ44US	IJ44	Surface bend actuator vented ink supply ink jet printer	
IJ45US	IJ45	Coil Acutuated Magnetic Plate Ink Jet Printer	

### Tables of Drop-on-Demand Inkjets

Eleven important characteristics of the fundamental operation of individual inkjet nozzles have been identified. These characteristics are largely orthogonal, and so can be elucidated as an eleven dimensional matrix. Most of the eleven axes of this matrix include entries developed by the present assignee.

The following tables form the axes of an eleven dimensional table of inkjet types.

Actuator mechanism (18 types)

10 Basic operation mode (7 types)

Auxiliary mechanism (8 types)

Actuator amplification or modification method (17 types)

Actuator motion (19 types)

Nozzle refill method (4 types)

Method of restricting back-flow through inlet (10 types)

Nozzle clearing method (9 types)

Nozzle plate construction (9 types)

Drop ejection direction (5 types)

Ink type (7 types)

The complete eleven dimensional table represented by these axes contains 36.9 billion possible configurations of inkjet nozzle. While not all of the possible combinations result in a viable inkjet technology, many million configurations are viable. It is clearly impractical to elucidate all of the possible configurations. Instead, certain inkjet types have been investigated in detail. These are designated IJ01 to IJ45 above.

Other inkjet configurations can readily be derived from these forty-five examples by substituting alternative configurations along one or more of the eleven

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axes. Most of the IJ01 to IJ45 examples can be made into inkjet print heads with characteristics superior to any currently available inkjet technology.

Where there are prior art examples known to the inventor, one or more of these examples are listed in the examples column of the tables below. The IJ01 to IJ45 series are also listed in the examples column. In some cases, a printer may be listed more than once in a table, where it shares characteristics with more than one entry.

Suitable applications include: Home printers, Office network printers, Short run digital printers, Commercial print systems, Fabric printers, Pocket printers, Internet WWW printers, Video printers, Medical imaging, Wide format printers, Notebook PC printers, Fax machines, Industrial printing systems, Photocopiers, Photographic minilabs etc.

The information associated with the aforementioned eleven dimensional matrix are set out in the following tables.

# ACTUATOR MECHANISM (APPLIED ONLY TO SELECTED INK DROPS)

Actuator Mechanism	Description	Advantages	Disadvantages	Examples
Thermal	An electrothermal heater heats the	<ul> <li>Large force generated</li> </ul>	◆ High power	<ul> <li>Canon Bubblejet</li> </ul>
pubble	ink to above boiling point,	<ul> <li>Simple construction</li> </ul>	<ul> <li>Ink carrier limited to water</li> </ul>	1979 Endo et al GB
	transferring significant heat to the	<ul> <li>No moving parts</li> </ul>	<ul> <li>◆ Low efficiency</li> </ul>	patent 2,007,162
	aqueous ink. A bubble nucleates	<ul> <li>Fast operation</li> </ul>	<ul> <li>High temperatures required</li> </ul>	♦ Xerox heater-in-pit
	and quickly forms, expelling the	<ul> <li>Small chip area required</li> </ul>	<ul> <li>High mechanical stress</li> </ul>	1990 Hawkins et al
	ink.	for actuator	<ul> <li>♦ Unusual materials required</li> </ul>	USF 4,899,181
	The efficiency of the process is		<ul> <li>◆ Large drive transistors</li> </ul>	<ul> <li>frewlett-rackard</li> <li>TII 1982 Vaught et</li> </ul>
	low, with typically less than		<ul> <li>Cavitation causes actuator failure</li> </ul>	al HSP 4 490 728
	0.05% of the electrical energy		<ul> <li>Kogation reduces bubble formation</li> </ul>	07/07/1 TO TH
	being transformed into kinetic		<ul> <li>Large print heads are difficult to</li> </ul>	
	energy of the drop.		fabricate	
Piezoelectric	A piezoelectric crystal such as	<ul> <li>Low power consumption</li> </ul>	<ul> <li>♦ Very large area required for actuator</li> </ul>	<ul> <li>♦ Kyser et al USP</li> </ul>
	lead lanthanum zirconate (PZT) is	<ul> <li>Many ink types can be</li> </ul>	<ul> <li>◆ Difficult to integrate with electronics</li> </ul>	3,946,398
	electrically activated, and either	nsed	<ul> <li>High voltage drive transistors</li> </ul>	◆ Zoltan USP
	expands, shears, or bends to apply	<ul> <li>Fast operation</li> </ul>	required	3,683,212
	pressure to the ink, ejecting drops.	<ul> <li>◆ High efficiency</li> </ul>	<ul> <li>Full pagewidth print heads</li> </ul>	◆ 1973 Stenume USP
	1	,	impractical due to actuator size	3,747,120
			<ul> <li>Requires electrical poling in high field</li> </ul>	<ul> <li>Epson Stylus</li> </ul>
		-	strengths during manufacture	<ul><li>◆ Tektronix</li></ul>
				◆ IJ04

<ul> <li>elaxor • Many ink types can be used used • Low thermal expansion • Electric field strength required (approx. 3.5 V/μm) can be generated without difficulty • Does not require electrical poling nduce • Low power consumption • he • Many ink types can be used • Fast operation (&lt; 1 μs) • Relatively high longitudinal strain • High efficiency • Electric field strength of around 3 V/μm can be readily provided ated • Low power consumption • Many ink types can be used  • Many ink types can be used • Low power consumption • Many ink types can be used a a  • Fast operation • Many ink types can be used  • Low power consumption • The plates • Fast operation • • Fast operation • • • • • • • • • • • • • • • • • • •</li></ul>	Electro-	An electric field is used to	<ul> <li>Low power consumption</li> </ul>	•	Low maximum strain (approx. 0.01%)	<ul> <li>Seiko Epson, Usui</li> </ul>
magnesium niobate (PMN).  * Low thermal expansion magnesium niobate (PMN).  * Electric field strength required (approx. 3.5 V/µm) can be generated without difficulty  * Does not require electrical poling antiferroelectric (AFE) and ferroelectric (AFE) and ferroelectric (FE) phase.  Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT)  * Relatively high modified lead lanthanum in lant	strictive	activate electrostriction in relaxor	<ul> <li>Many ink types can be</li> </ul>	•	Large area required for actuator due	et all JP 253401/96
zirconate titanate (PLZT) or lead		materials such as lead lanthanum	pesn		to low strain	<ul><li>◆ IJ04</li></ul>
magnesium niobate (PMN).  Bectric field strength required (approx. 3.5 V/µm) can be generated without difficulty  Does not require electrical poling  An electric field is used to induce bused ferroelectric (AFE) and ferroelectric (FE) phase.  Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT)		zirconate titanate (PLZT) or lead	<ul> <li>Low thermal expansion</li> </ul>	•	Response speed is marginal (~ 10 µs)	
required (approx. 3.5  V/µm) can be generated without difficulty  Does not require electrical poling  An electric field is used to induce a phase transition between the antiferroelectric (AFE) and ferroelectric (FE) phase.  Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT)		magnesium niobate (PMN).	<ul> <li>Electric field strength</li> </ul>	•	High voltage drive transistors	
<ul> <li>V/μm) can be generated without difficulty</li> <li>Does not require electrical poling</li> <li>a phase transition between the antiferroelectric (AFE) and ferroelectric (FE) phase.</li> <li>Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT)</li> <li>Exhibit large strains of up to 1%</li> <li>Exhibit large strains of up to 1%</li> <li>Electric field strength of associated with the AFE to FE readily provided phase transition.</li> <li>Conductive plates are separated</li> <li>Many ink types can be readily provided</li> <li>Dy a compressible or fluid dielectric (usually air). Upon application of a voltage, the plates are separated conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface</li> </ul>		,	required (approx. 3.5	_	required	
<ul> <li>without difficulty</li> <li>Does not require electrical poling</li> <li>antiferroelectric (AFE) and ferroelectric (AFE) and ferroelectric (AFE) and ferroelectric (AFE) and modified lead lanthanum zirconate titanate (PLZSnT)</li> <li>Relatively high modified lead lanthanum zirconate titanate (PLZSnT)</li> <li>Electric field strength of associated with the AFE to FE readily provided phase transition.</li> <li>Destatic Conductive plates are separated by a compressible or fluid dielectric (usually air). Upon application of a voltage, the plates aftract each other and displace ink, causing drop ejection. The conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface</li> </ul>			$V/\mu m$ ) can be generated	•	Full pagewidth print heads	
<ul> <li>Does not require electrical poling</li> <li>a phase transition between the antiferroelectric (AFE) and ferroelectric (FE) phase.</li> <li>Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT)</li> <li>Electric field strength of associated with the AFE to FE readily provided</li> <li>Conductive plates are separated by a compressible or fluid dielectric (usually air). Upon application of a voltage, the plates at comb or honeycomb structure, or stacked to increase the surface</li> <li>State Does not require electrical poling</li> <li>Many ink types can be readily provided</li> <li>Low power consumption</li> <li>Many ink types can be readily provided</li> <li>Many ink types can be used</li> <li>Many ink types can be used</li> <li>Many ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used dielectric (usually air). Upon</li> <li>Amany ink types can be used used used used use</li></ul>			without difficulty		impractical due to actuator size	
poling  An electric field is used to induce a phase transition between the antiferroelectric (AFE) and ferroelectric (FE) phase.  Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT) exhibit large strains of up to 1% associated with the AFE to FE readily provided phase transition.  Static Conductive plates are separated by a compressible or fluid application of a voltage, the plates attract each other and displace ink, causing drop ejection. The conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface			<ul> <li>Does not require electrical</li> </ul>			
<ul> <li>a phase transition between the antiferroelectric (AFE) and ferroelectric (FE) phase.</li> <li>Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT)</li> <li>Exhibit large strains of up to 1% associated with the AFE to FE readily provided phase transition.</li> <li>Conductive plates are separated dielectric (usually air). Upon application of a voltage, the plates in x, causing drop ejection. The conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface</li> <li>Low power consumption are displace in x, causing drop ejection. The conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface</li> </ul>			poling			
a phase transition between the antiferroelectric (AFE) and ferroelectric (BE F	Ferroelectric	An electric field is used to induce	<ul> <li>Low power consumption</li> </ul>	•	Difficult to integrate with electronics	<ul><li>◆ IJ04</li></ul>
antiferroelectric (AFE) and ferroelectric (FE) phase.  Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT)  exhibit large strains of up to 1% associated with the AFE to FE phase transition.  Conductive plates are separated by a compressible or fluid attract each other and displace ink, causing drop ejection. The conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface  ferroelectric (HE) phase.  Relatively high longing high efficiency around 3 V/µm can be readily provided  Perovskite materials such a Fast operation of a voltage, the plates are separated by a compressible or fluid attract each other and displace in a comb or honeycomb structure, or stacked to increase the surface		a phase transition between the	<ul> <li>Many ink types can be</li> </ul>	•	Unusual materials such as PLZSnT	
ferroelectric (FE) phase.  Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT) exhibit large strains of up to 1% associated with the AFE to FE readily provided phase transition.  Static Conductive plates are separated by a compressible or fluid application of a voltage, the plates attract each other and displace ink, causing drop ejection. The comb or honeycomb structure, or stacked to increase the surface		antiferroelectric (AFE) and	nsed		are required	
Perovskite materials such as tin modified lead lanthanum zirconate titanate (PLZSnT)		ferroelectric (FE) phase.	<ul> <li>Fast operation (&lt; 1 μs)</li> </ul>	•	Actuators require a large area	
modified lead lanthanum  zirconate titanate (PLZSnT) exhibit large strains of up to 1% exhibit large strains of up 1% expending the AFE to FE errain from the AFE errain from the		Perovskite materials such as tin	<ul> <li>Relatively high</li> </ul>			
zirconate titanate (PLZSnT)    exhibit large strains of up to 1%    associated with the AFE to FE    phase transition.  Conductive plates are separated    by a compressible or fluid    application of a voltage, the plates    attract each other and displace    ink, causing drop ejection. The    conductive plates may be in a    comb or honeycomb structure, or    stacked to increase the surface     High efficiency    Electric field strength of    around 3 V/µm can be    readily provided    Many ink types can be    used    Fast operation    taked		modified lead lanthanum	longitudinal strain			
exhibit large strains of up to 1% associated with the AFE to FE readily provided phase transition.  Static Conductive plates are separated by a compressible or fluid application of a voltage, the plates attract each other and displace ink, causing drop ejection. The conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface		zirconate titanate (PLZSnT)	<ul> <li>High efficiency</li> </ul>			
associated with the AFE to FE readily provided phase transition.  Conductive plates are separated by a compressible or fluid dielectric (usually air). Upon application of a voltage, the plates attract each other and displace ink, causing drop ejection. The conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface		exhibit large strains of up to 1%	<ul> <li>Electric field strength of</li> </ul>			
phase transition.  Conductive plates are separated by a compressible or fluid application of a voltage, the plates attract each other and displace ink, causing drop ejection. The comb or honeycomb structure, or stacked to increase the surface		associated with the AFE to FE	around 3 V/µm can be			
by a compressible or fluid by a compressible or fluid dielectric (usually air). Upon application of a voltage, the plates attract each other and displace ink, causing drop ejection. The conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface		phase transition.	readily provided			
by a compressible or fluid dielectric (usually air). Upon application of a voltage, the plates attract each other and displace ink, causing drop ejection. The conductive plates may be in a comb or honeycomb structure, or stacked to increase the surface	Electrostatic	Conductive plates are separated	<ul> <li>Low power consumption</li> </ul>	•	Difficult to operate electrostatic	<ul> <li>◆ IJ02, IJ04</li> </ul>
used  Rast operation	plates	by a compressible or fluid	<ul> <li>Many ink types can be</li> </ul>		devices in an aqueous environment	
s + Fast operation		dielectric (usually air). Upon	nsed	•	The electrostatic actuator will	
<b>* *</b>		application of a voltage, the plates	<ul> <li>Fast operation</li> </ul>		normally need to be separated from	
• •		attract each other and displace			the ink	
•		ink, causing drop ejection. The		•	Very large area required to achieve	
•		conductive plates may be in a			high forces	
•		comb or honeycomb structure, or		•	High voltage drive transistors may be	
		stacked to increase the surface			required	
•		area and therefore the force.		•	Full pagewidth print heads are not	

Flootroctotio	A -4	▲ I our current concumption	2	High wolfens required	▲ 1080 Caita at al
Lieunosiano	A suong electric near 18 applied		• · 	ingii voimge required	1707 Sain Ct al,
All oll but	to the ink, whereupon electrostatic	• Low temperature	_	May be damaged by sparks due to air	USF 4,723,000
	attraction accelerates the ink			breakdown	<ul> <li>◆ 1989 Miura et al,</li> </ul>
	towards the print medium.		<u> </u>	Required field strength increases as	USP 4,810,954
	•			the drop size decreases	<ul><li>Tone-jet</li></ul>
			•	High voltage drive transistors	
			•	required	
	and a proper proper and a second seco		•	Electrostatic field attracts dust	
Permanent	An electromagnet directly attracts	<ul> <li>Low power consumption</li> </ul>	•	Complex fabrication	◆ IJ07, IJ10
magnet	a permanent magnet, displacing	<ul> <li>Many ink types can be</li> </ul>	_	Permanent magnetic material such as	
electro-	ink and causing drop ejection.	nseq		Neodymium Iron Boron (NdFeB)	
magnetic	Rare earth magnets with a field	<ul> <li>Fast operation</li> </ul>		required.	
	strength around 1 Tesla can be	<ul> <li>High efficiency</li> </ul>	•	High local currents required	
	used. Examples are: Samarium	<ul> <li>Easy extension from single</li> </ul>	ele 🔸	Copper metalization should be used	
	Cobalt (SaCo) and magnetic	nozzles to pagewidth print	ıt.	for long electromigration lifetime and	
	materials in the neodymium iron	heads		low resistivity	
	boron family (NdFeB,		•	Pigmented inks are usually infeasible	
	NdDyFeBNb, NdDyFeB, etc)		•	Operating temperature limited to the	
				Curie temperature (around 540 K)	
Soft magnetic	A solenoid induced a magnetic	<ul> <li>Low power consumption</li> </ul>	•	Complex fabrication	<ul> <li>IJ01, IJ05, IJ08,</li> </ul>
core electro-	field in a soft magnetic core or	<ul> <li>Many ink types can be</li> </ul>	•	Materials not usually present in a	1110
magnetic	yoke fabricated from a ferrous	nsed		CMOS fab such as NiFe, CoNiFe, or	<ul> <li>IJ12, IJ14, IJ15,</li> </ul>
	material such as electroplated iron	<ul> <li>Fast operation</li> </ul>		CoFe are required	1317
	alloys such as CoNiFe [1], CoFe,	<ul> <li>High efficiency</li> </ul>	•	High local currents required	
	or NiFe alloys. Typically, the soft	◆ Easy extension from single	• el	Copper metalization should be used	
	magnetic material is in two parts,	nozzles to pagewidth print		for long electromigration lifetime and	
	which are normally held apart by	heads	-	low resistivity	
	a spring. When the solenoid is		•	Electroplating is required	
	actuated, the two parts attract,		•	High saturation flux density is	
	displacing the ink.			required (2.0-2.1 T is achievable with CoNiFe [11)	
			-	(11)	

Magnetic	The Lorenz force acting on a	◆ Low power consumption	•	Force acts as a twisting motion	◆ IJ06, IJ11, IJ13,
Lorenz force	current carrying wire in a	<ul> <li>Many ink types can be</li> </ul>	•	Typically, only a quarter of the	1116
	magnetic field is utilized.	nseq		solenoid length provides force in a	
	This allows the magnetic field to	• Fast operation	•	useful direction	
	be supplied externally to the print	• Figh efficiency	•	Onner metalization chould be used	
	head, for example with rare earth	<ul> <li>Easy extension from single nozzles to nagewidth print</li> </ul>	•	for long electromigration lifetime and	
	permanent magnets.	heads		low resistivity	
	Only the current carrying wire		•	Pigmented inks are usually infeasible	
	need be rabilitated on the print- head, simplifying materials				
	requirements.				
Magneto-	The actuator uses the giant	<ul> <li>Many ink types can be</li> </ul>	•	Force acts as a twisting motion	<ul> <li>Fischenbeck, USP</li> </ul>
striction	magnetostrictive effect of	nseq	•	Unusual materials such as Terfenol-D	4,032,929
	materials such as Terfenol-D (an	<ul> <li>Fast operation</li> </ul>		are required	<ul><li>1025</li></ul>
	alloy of terbium, dysprosium and	• Easy extension from single	•	High local currents required	
	iron developed at the Naval	nozzles to pagewidth print	•	Copper metalization should be used	
	Ordnance Laboratory, hence Ter-	heads		for long electromigration lifetime and	
	Fe-NOL). For best efficiency, the	<ul> <li>High force is available</li> </ul>		low resistivity	
	actuator should be pre-stressed to		•	Pre-stressing may be required	
	approx. 8 MPa.				
Surface	Ink under positive pressure is held	<ul> <li>Low power consumption</li> </ul>	•	Requires supplementary force to	<ul> <li>Silverbrook, EP</li> </ul>
tension	in a nozzle by surface tension.	<ul> <li>Simple construction</li> </ul>		effect drop separation	0771 658 A2 and
reduction	The surface tension of the ink is	<ul> <li>No unusual materials</li> </ul>	•	Requires special ink surfactants	related patent
	reduced below the bubble	required in fabrication	•	Speed may be limited by surfactant	applications
	threshold, causing the ink to	<ul> <li>High efficiency</li> </ul>		properties	
	egress from the nozzle.	<ul> <li>Easy extension from single</li> </ul>			
		nozzles to pagewidth print			
		neads			

Viscosity	The ink viscosity is locally	♦ Simple	Simple construction	* **	Requires supplementary force to	•	Silverbrook, EP
reduction	reduced to select which drops are	nun oN 🔸	No unusual materials	<u>ئ</u>	effect drop separation		0771 658 A2 and
	to be ejected. A viscosity	require	required in fabrication	<b>₩</b>	Requires special ink viscosity		related patent
	reduction can be achieved	◆ Easy ex	Easy extension from single	ď	properties		applications
	electrothermally with most inks,	nozzles	nozzles to pagewidth print	H •	High speed is difficult to achieve		
	but special inks can be engineered	heads		<b>₩</b>	Requires oscillating ink pressure		
	for a 100:1 viscosity reduction.			<b>∀</b>	A high temperature difference		
				t)	(typically 80 degrees) is required		
Acoustic	An acoustic wave is generated and	◆ Can ope	Can operate without a	•	Complex drive circuitry	•	1993 Hadimioglu et
	focussed upon the drop ejection	nozzle plate	olate	•	Complex fabrication		al, EUP 550,192
	region.		-	- T	Low efficiency	•	1993 Elrod et al,
				• Р	Poor control of drop position		EUP 572,220
				♦ P	Poor control of drop volume		
Thermoelastic	An actuator which relies upon	◆ Low po	Low power consumption	<b>田</b>	Efficient aqueous operation requires a	•	1J03, 1J09, 1J17,
bend actuator	differential thermal expansion	◆ Many in	Many ink types can be	⇌	thermal insulator on the hot side		IJ18
	upon Joule heating is used.	nseq		•	Corrosion prevention can be difficult	•	IJ19, IJ20, IJ21,
	1	♦ Simple	Simple planar fabrication	• P	Pigmented inks may be infeasible, as		1322
		◆ Small c	Small chip area required	ď	pigment particles may jam the bend	•	133, 1324, 1327,
		for each	for each actuator	ĕ	actuator		IJ28
		<ul> <li>Fast operation</li> </ul>	eration			•	U29, U30, U31,
		+ High ef	High efficiency				1132
		◆ CMOS	CMOS compatible			•	133, 134, 135,
		voltages	voltages and currents				136
		◆ Standar	Standard MEMS processes			•	1137, 1138 ,1139,
- B		can be used	pesi				1.040
		◆ Easy ex	Easy extension from single			•	1141
		nozzles	nozzles to pagewidth print				
		heads					

High CTE	A material with a very high	<ul> <li>High force can be</li> </ul>	<b>☆</b>	Requires special material (e.g. PTFE)	•	1109, 1117, 1118,
thermoelastic	coefficient of thermal expansion	generated	*	Requires a PTFE deposition process,		1720
actuator	(CTE) such as	<ul> <li>PTFE is a candidate for</li> </ul>	≱	which is not yet standard in ULSI fabs	•	П21, П22, П23,
	nolytetrafluoroethylene (PTFE) is	low dielectric constant	ф Р	PTFE deposition cannot be followed		1J24
	used. As high CTE materials are	insulation in ULSI	8	with high temperature (above 350 °C)	•	1127, 1128, 1129,
	usually non-conductive, a heater	<ul> <li>Very low power</li> </ul>	₫,	processing		1130
	fabricated from a conductive	consumption	<b>♦</b>	Pigmented inks may be infeasible, as	•	1131, 1142, 1143,
	material is incomprated A 50 Hm	<ul> <li>Many ink types can be</li> </ul>	Ē,	pigment particles may jam the bend		1344
	long DTFF hand actuator with	nseq	ä	actuator		,
	noing 1 11 to Oction accuration with	<ul> <li>Simple planar fabrication</li> </ul>				
	porteniamit on arounde 180N	<ul> <li>Small chip area required</li> </ul>				
	power input can provide 180 mis	for each actuator				
	torce and 10 µm deflection.	<ul> <li>Fast operation</li> </ul>				
	Actuator motions include:	◆ High efficiency				
	Bend	◆ CMOS compatible				
	Push	voltages and currents				
	Buckle	<ul> <li>Easy extension from single</li> </ul>				
	Rotate	nozzles to pagewidth print				
		heads				

substances to increase its substances to increase its conductivity to about 3 orders of magnitude below that of copper. The conducting polymer expands when resistively heated. Examples of conducting dopants include: Carbon nanotubes  Metal fibers  Carbon granules  Ory A shape memory alloy such as Tinki (also known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance  Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic shape change causes ejection of a substance on shape change causes ejection of a conduction graph of the actuator in the shape of the actuator in the shape change causes ejection of a conduction graph of the actuator in the sustenic shape. The	Conductive	A polymer with a high coefficient	♦ High force can be	<ul> <li>Requires special materials</li> </ul>		♦ IJ24
substances to increase its conductivity to about 3 orders of magnitude below that of copper. The conducting polymer expands when resistively heated. Examples of conducting dopants include: Carbon manotubes Metal fibers Conductive polymers such as doped polythiophene Carbon granules  Metal fibers Conductive polymers such as depend polythiophene Carbon granules  Metal fibers Conductive polymers such as depend polythiophene Carbon granules  Metal fibers Conductive polymers such as depend polythiophene Carbon granules  Metal fibers  Carbon granules  High force is available TiNi (also known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in its martensitic state is deformed relative to the austenic shape. The shape change causes ejection of a  Lord proper propers and currents Carbon granules  High force is available or gresses of hundreds of more than 3%)  High correction pages and currents Carbon granules  High force is available or gresses of hundreds of more than 3%)  High correction pages and currents Carbon granules  High force is available or gresses of hundreds of more than 3%)  High correction resistance or gresses and currents  Easy extension from single or gresses of hundreds of more than 3%)  High correction or gresses of hundreds of more than 3%)  Easy extension from single or gresses of hundreds of more than 3%)  Easy extension from single or gresses of hundreds of more than 3%)  Easy extension from single or gresses of pagewidth print or gresses of pagewidth print or gresses of gresses	polymer	of thermal expansion (such as	generated	development (High CTE conductive	nductive	
conductivity to about 3 orders of magnitude below that of copper.  The conductivity to about 3 orders of magnitude below that of copper.  The conductivity to about 3 orders of magnitude below that of copper.  The conductivity to about 3 orders of magnitude below that of copper.  Examples of conducting dopants include:  Carbon nanotubes  Metal fibers  Conductive polymers such as doped polythiophene  Carbon granules  Carbon granules  Carbon granules  Carbon granules  A shape memory alloy such as TiNi (also known as Nitinol-Airi (a	thermoelastic	PTFE) is doped with conducting	<ul> <li>Very low power</li> </ul>	polymer)		
conductivity to about 3 orders of magnitude below that of copper.  The conducting polymer expands when resistively heated.  Examples of conducting dopants include:  Carbon nanotubes  Metal fibers  Conductive polymers such as doped polythiophene  Carbon granules	actuator	substances to increase its	consumption	<ul> <li>Requires a PTFE deposition process,</li> </ul>	n process,	
magnitude below that of copper.  The conducting polymer expands when resistively heated.  Examples of conducting dopants include:  Carbon nanotubes  Metal fibers  Conductive polymers such as doped polythiophene  Carbon granules  CMOS compatible  Voltages and currents  Carbon granules  CMOS compatible  Voltages and currents  Carbon granules  Carbon granith print erast or pagewidth print erast is deformed  Carbon granith for carbon graniable  Carbon graniabl		conductivity to about 3 orders of	<ul> <li>Many ink types can be</li> </ul>	which is not yet standard in ULSI fabs	ULSI fabs	
The conducting polymer expands when resistively heated.  Examples of conducting dopants include:  Carbon nanotubes  Metal fibers  Conductive polymers such as doped polythiophene  Carbon granules  TiNi (also known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance  Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in its martensitic state is deformed relative to the austenic shape. The shape change causes ejection of a conversion of a conv		magnitude below that of copper.	nsed	<ul> <li>PTFE deposition cannot be followed</li> </ul>	followed	
when resistively heated.  Examples of conducting dopants include:  Carbon nanotubes  Metal fibers  Conductive polymers such as doped polythiophene  Carbon granules  Carbon granules  Carbon granules  Carbon de Visio known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance  Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in its martensitic state is deformed relative to the austenic shape. The shape change causes ejection of a large strain is avoilage operation resistince shape. The shape change causes ejection of a large strain is avoilage operation resistince shape. The shape change causes ejection of a large strain is avoilage operation resistince shape. The shape change causes ejection of a large strain is avoilage operation resistance shape change causes ejection of a large strain is avoilage operation resistance shape change causes ejection of a large strain is avoilage operation resistance shape change causes ejection of a large strain is avoilage operation shape change causes ejection of a large strain is avoilage operation shape change causes ejection of a large strain is avoilage operation shape change causes ejection of a large strain is avoilage operation shape change causes ejection of a large strain is avoilage operation shape change causes ejection of a large strain is avoilage operation shape shape of the actuator in strain shape sha		The conducting polymer expands	<ul> <li>Simple planar fabrication</li> </ul>	with high temperature (above 350 °C)	ve 350 °C)	
Examples of conducting dopants include:  Carbon nanotubes  Metal fibers  Conductive polymers such as doped polythiophene  Carbon granules  CMOS compatible  CMOS compatible  CMOS  CMOS compatible  CMOS  CMO		when resistively heated.	<ul> <li>Small chip area required</li> </ul>	processing		
include: Carbon nanotubes Metal fibers Conductive polymers such as doped polythiophene Carbon granules  e memory A shape memory alloy such as TiNi (also known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in its martensitic state is deformed relative to the austenic shape. The shape change causes ejection of a  High efficiency CMOS compatible High efficiency CMOS compatible High efficiency High efficiency High efficiency CMOS compatible High efficiency High efficiency High efficiency CMOS compatible High efficiency High efficiency CMOS compatible High force is available (more than 3%) High corresistance  Easy extension from single (more than 3%) High corresistance  Easy extension from single (more than 3%) High corresistance  Easy extension from single High corresion resistance  Easy extension from single High corresion from single High corresion from single High correction of a		Examples of conducting donants	for each actuator	<ul> <li>Evaporation and CVD deposition</li> </ul>	sition	
<ul> <li>Carbon nanotubes</li> <li>Metal fibers</li> <li>Conductive polymers such as doped polythiophene</li> <li>Carbon granules</li> <li>Easy extension from single nozzles to pagewidth print heads</li> <li>Easy extension from single nozzles to pagewidth print heads</li> <li>Easy extension from single nozzles to pagewidth print the heads</li> <li>Easy extension from single nozzles to pagewidth print the heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> <li>Easy extension from single nozzles to pagewidth print that heads</li> </ul>		include:	<ul> <li>Fast operation</li> </ul>	techniques cannot be used	•	
<ul> <li>Metal fibers     Conductive polymers such as doped polythiophene     Carbon granules     Carbon g</li></ul>		Carbon nanotubes	<ul> <li>High efficiency</li> </ul>	<ul> <li>Pigmented inks may be inteasible, as</li> </ul>	easible, as	
Conductive polymers such as doped polythiophene  Carbon granules  • memory A shape memory alloy such as TiNi (also known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance  Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in its martensitic state is deformed relative to the austenic shape. The shape change causes ejection of a shape change causes ejection of a conductive page width print adopted polythiophene and carbon granules and carbon granules and currents heads and curren		Metal fibers	• CMOS compatible	pignicit particies may jam t	חוב חבוות	
<ul> <li>e memory polyhiophene</li> <li>Carbon granules</li> <li>Peasy extension from single nozzles to pagewidth print heads</li> <li>TiNi (also known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in its martensitic state is deformed relative to the austenic shape. The shape change causes ejection of a</li> <li>Easy extension from single nozzles to pagewidth print heads</li> <li>Laboratory (stresses of hundreds of MPa)</li> <li>Laboratory (stresses of hundreds of MPa)</li> <li>Earge strain is available (more than 3%)</li> <li>High corrosion resistance (more than 3%)</li> <li>Easy extension from single nozzles to pagewidth print heads</li> <li>Low voltage operation</li> </ul>		Conductive nolymers such as	voltages and currents			
<ul> <li>e memory A shape memory alloy such as TiNi (also known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in its martensitic state is deformed relative to the austenic shape. The shape change causes ejection of a</li> <li>e memory A shape memory alloy such as (stresses of hundreds of (stresses of hundreds of (stresses of hundreds of (more than 3%)</li> <li>heads</li> <li>Large strain is available (more than 3%)</li> <li>High force is available (stresses of hundreds o</li></ul>		doped nolythiophene	• Easy extension from single			
<ul> <li>e memory A shape memory alloy such as TiNi (also known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in state. The shape of the actuator in relative to the austenic shape. The shape change causes ejection of a</li> <li>e memory A shape force is available (stresses of hundreds of the available (more than 3%)</li> <li>e High force is available (stresses of hundreds of the available (more than 3%)</li> <li>e High force is available (more than 3%)</li> <li>e High force is available (more than 3%)</li> <li>e High force is available (more than 3%)</li> <li>e High corrosion resistance (more than 3%)</li> <li>e High corrosion resistance (more than 3%)</li> <li>e High corrosion from single (more than 3%)</li> <li>e High corrosion from 3%</li> <li>e High cor</li></ul>		Carbon granules	heads			
<ul> <li>e memory A shape memory alloy such as TiNi (also known as Nitinol - Nickel Titanium alloy developed at the Naval Ordnance Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in its martensitic state is deformed relative to the austenic shape. The shape change causes ejection of a</li> <li>High force is available (stresses of hundreds of MPa)</li> <li>Large strain is available (more than 3%)</li> <li>High corrosion resistance simple construction</li> <li>Simple construction hordinge operation</li> <li>Lasy extension from single nozzles to pagewidth print heads</li> <li>Low voltage operation</li> </ul>		Caroon grandes	2000			
TiNi (also known as Nitinol - MPa)  Nickel Titanium alloy developed at the Naval Ordnance Laboratory) is thermally switched between its weak martensitic state and its high stiffness austenic state. The shape of the actuator in its martensitic state is deformed relative to the austenic shape. The shape change causes ejection of a	Shape memory	A shape memory alloy such as	<ul> <li>High force is available</li> </ul>	<ul> <li>Fatigue limits maximum number of</li> </ul>	mber of	<ul><li>■ IJ26</li></ul>
<ul> <li>MPa)</li> <li>Large strain is available (more than 3%)</li> <li>High corrosion resistance</li> <li>Simple construction</li> <li>Easy extension from single nozzles to pagewidth print heads</li> <li>Low voltage operation</li> </ul>	alloy	TiNi (also known as Nitinol -	(stresses of hundreds of	cycles		
<ul> <li>Large strain is available (more than 3%)</li> <li>High corrosion resistance</li> <li>Simple construction</li> <li>Easy extension from single nozzles to pagewidth print heads</li> <li>Low voltage operation</li> </ul>		Nickel Titanium alloy developed	MPa)	◆ Low strain (1%) is required to extend	to extend	
<ul> <li>(more than 3%)</li> <li>High corrosion resistance</li> <li>Simple construction</li> <li>Easy extension from single nozzles to pagewidth print heads</li> <li>Low voltage operation</li> </ul>		at the Naval Ordnance	<ul> <li>Large strain is available</li> </ul>	fatigue resistance		
<ul> <li>High corrosion resistance</li> <li>Simple construction</li> <li>Easy extension from single</li> <li>nozzles to pagewidth print</li> <li>heads</li> <li>Low voltage operation</li> </ul>		Laboratory) is thermally switched	(more than 3%)	<ul> <li>Cycle rate limited by heat removal</li> </ul>	emoval	
<ul> <li>Simple construction</li> <li>Easy extension from single nozzles to pagewidth print heads</li> <li>Low voltage operation</li> </ul>		between its weak martensitic state	<ul> <li>High corrosion resistance</li> </ul>	<ul> <li>Requires unusual materials (TiNi)</li> </ul>	(TiNi)	
<ul> <li>Easy extension from single nozzles to pagewidth print heads</li> <li>Low voltage operation</li> </ul>		and its high stiffness austenic	<ul> <li>Simple construction</li> </ul>	<ul> <li>The latent heat of transformation must</li> </ul>	lation must	
nozzles to pagewidth print heads  Low voltage operation		state. The shape of the actuator in	<ul> <li>Easy extension from single</li> </ul>	be provided		
heads  Low voltage operation		its martensitic state is deformed	nozzles to pagewidth print	<ul> <li>High current operation</li> </ul>		
◆ Low voltage operation		relative to the austenic shape. The	heads	<ul> <li>Requires pre-stressing to distort the</li> </ul>	stort the	
		shape change causes ejection of a	<ul> <li>◆ Low voltage operation</li> </ul>	martensitic state		
drop.		drop.				

◆ IJ12									
Requires unusual semiconductor	materials such as soft magnetic alloys	(e.g. CoNiFe [1])	<ul> <li>Some varieties also require permanent</li> </ul>	magnetic materials such as	Neodymium iron boron (NdFeB)	Requires complex multi-phase drive	circuitry	▶ High current operation	
)rs +			<u>♦</u> 8			•		ole +	
<ul> <li>◆ Linear Magnetic actuators</li> </ul>	can be constructed with	high thrust, long travel,	and high efficiency using	planar semiconductor	fabrication techniques	Long actuator travel is	available	Medium force is available	Low voltage operation
-						•		•	•
Linear magnetic actuators include	the Linear Induction Actuator	(LIA), Linear Permanent Magnet	Synchronous Actuator (LPMSA)	I inear Reluctance Synchronous	Actiofor (TDCA) Tipeor	Switched Pellictance Actuator	G CD A) and the I incom Ctenner	Actuator (TSA)	Actuator (LOA).
Linear	Magnetic	Actuator							

## BASIC OPERATION MODE

Operational mode	Description	Advantages	Disadvantages	Examples
Actuator directly pushes ink	This is the simplest mode of operation: the actuator directly supplies sufficient kinetic energy to expel the drop. The drop must have a sufficient velocity to overcome the surface tension.	<ul> <li>Simple operation</li> <li>No external fields required</li> <li>Satellite drops can be avoided if drop velocity is less than 4 m/s</li> <li>Can be efficient, depending upon the actuator used</li> </ul>	<ul> <li>Drop repetition rate is usually limited to less than 10 KHz. However, this is not fundamental to the method, but is related to the refill method normally used</li> <li>All of the drop kinetic energy must be provided by the actuator</li> <li>Satellite drops usually form if drop velocity is greater than 4.5 m/s</li> </ul>	<ul> <li>Thermal inkjet</li> <li>Piezoelectric inkjet</li> <li>IJ01, IJ02, IJ03, IJ04</li> <li>IJ09</li> <li>IJ11, IJ12, IJ14, IJ16</li> <li>IJ20, IJ22, IJ23, IJ24</li> <li>IJ28</li> <li>IJ28, IJ26, IJ27, IJ28</li> <li>IJ28</li> <li>IJ29, IJ30, IJ31, IJ32</li> <li>IJ31, IJ32, IJ35, IJ36, IJ36, IJ36</li> <li>IJ31, IJ34, IJ35, IJ36, IJ36, IJ36</li> <li>IJ37, IJ38, IJ39, IJ40</li> <li>IJ44</li> <li>IJ44</li> </ul>
Proximity	The drops to be printed are selected by some manner (e.g. thermally induced surface tension reduction of pressurized ink). Selected drops are separated from the ink in the nozzle by contact with the print medium or a transfer roller.	<ul> <li>Very simple print head fabrication can be used</li> <li>The drop selection means does not need to provide the energy required to separate the drop from the nozzle</li> </ul>	<ul> <li>Requires close proximity between the print head and the print media or transfer roller</li> <li>May require two print heads printing alternate rows of the image</li> <li>Monolithic color print heads are difficult</li> </ul>	• Silverbrook, EP 0771 658 A2 and related patent applications

Electrostatic	The drops to be printed are	<ul> <li>Very simple print head</li> </ul>	•	Requires very high electrostatic field	◆ Silverb	Silverbrook, EP
pull on ink	selected by some manner (e.g.	fabrication can be used	•	Electrostatic field for small nozzle	0771 6	0771 658 A2 and
	thermally induced surface tension	<ul> <li>The drop selection means</li> </ul>		sizes is above air breakdown	related patent	patent
	reduction of pressurized ink).	does not need to provide	•	Electrostatic field may attract dust	applications	tions
	Selected drops are separated from	the energy required to separate the drop from the			◆ Tone-Jet	*
	the ink in the nozzle by a strong electric field.	nozzle				
Magnetic pull	The drops to be printed are	<ul> <li>Very simple print head</li> </ul>	•	Requires magnetic ink	◆ Silverb	Silverbrook, EP
on ink	selected by some manner (e.g.	fabrication can be used	•	Ink colors other than black are	0771 6	0771 658 A2 and
	thermally induced surface tension	<ul> <li>The drop selection means</li> </ul>		difficult	related patent	patent (
	reduction of pressurized ink).	does not need to provide	•	Requires very high magnetic fields	applications	nons
	Selected drops are separated from	the energy required to				
	the ink in the nozzle by a strong	separate the drop from the				
	magnetic field acting on the	110ZZIC				
	magnetic ink.					
Shutter	The actuator moves a shutter to	<ul> <li>High speed (&gt;50 KHz)</li> </ul>	•	Moving parts are required	<ul> <li>↓ 1013, 1017, 1021</li> </ul>	17, IJ21
	block ink flow to the nozzle. The	operation can be achieved	•	Requires ink pressure modulator		
	ink pressure is pulsed at a	due to reduced refill time	•	Friction and wear must be considered		
	multiple of the drop ejection	<ul> <li>Drop timing can be very</li> </ul>	•	Stiction is possible		
	frequency	accurate				
	. ( )	<ul> <li>The actuator energy can be</li> </ul>				
		very low				
Shuttered grill	The actuator moves a shutter to	<ul> <li>Actuators with small travel</li> </ul>	•	Moving parts are required	◆ IJ08, IJ	JO8, IJ15, IJ18,
	block ink flow through a grill to	can be used	•	Requires ink pressure modulator	1119	
	the nozzle. The shutter movement	<ul> <li>Actuators with small force</li> </ul>	•	Friction and wear must be considered		
	need only be equal to the width of	can be used	•	Stiction is nossible		
	the grill holes.	<ul> <li>High speed (&gt;50 KHz)</li> </ul>				
		operation can be achieved				

Pulsed magnetic pull	A pulsed magnetic field attracts an 'ink misher' at the dron	<ul> <li>Extremely low energy operation is possible</li> </ul>	◆ Requires an external pulsed magnetic ← IJ10 field	ulsed magnetic	• IJ10
on ink pusher	ejection frequency. An actuator	<ul> <li>No heat dissipation problems</li> </ul>	<ul> <li>Requires special materials for both the actuator and the ink pusher</li> </ul>	ials for both the	
	the ink pusher from moving when	•	Complex construction		٠
:	a drop is not to be ejected.				

# AUXILIARY MECHANISM (APPLIED TO ALL NOZZLES)

Auxiliary Mechanism	Description	Advantages	Disadvantages	Examples
None	The actuator directly fires the ink drop, and there is no external field or other mechanism required.	<ul> <li>Simplicity of construction</li> <li>Simplicity of operation</li> <li>Small physical size</li> </ul>	<ul> <li>Drop ejection energy must be supplied by individual nozzle actuator</li> </ul>	<ul> <li>Most inkjets, including piezoelectric and thermal bubble.</li> <li>IJ01- IJ07, IJ09, IJ11</li> <li>IJ12, IJ14, IJ20, IJ22</li> <li>IJ23-IJ45</li> </ul>
Oscillating ink pressure (including acoustic stimulation)	The ink pressure oscillates, providing much of the drop ejection energy. The actuator selects which drops are to be fired by selectively blocking or enabling nozzles. The ink pressure oscillation may be achieved by vibrating the print head, or preferably by an actuator in the ink supply.	<ul> <li>Oscillating ink pressure can provide a refill pulse, allowing higher operating speed</li> <li>The actuators may operate with much lower energy</li> <li>Acoustic lenses can be used to focus the sound on the nozzles</li> </ul>	<ul> <li>Requires external ink pressure         oscillator</li> <li>Ink pressure phase and amplitude         must be carefully controlled</li> <li>Acoustic reflections in the ink         chamber must be designed for</li> </ul>	<ul> <li>Silverbrook, EP 0771 658 A2 and related patent applications</li> <li>IJ08, IJ13, IJ15, IJ17</li> <li>IJ17</li> <li>IJ18, IJ19, IJ21</li> </ul>
Media proximity	The print head is placed in close proximity to the print medium. Selected drops protrude from the print head further than unselected drops, and contact the print medium. The drop soaks into the medium fast enough to cause drop separation.	<ul> <li>Low power</li> <li>High accuracy</li> <li>Simple print head construction</li> </ul>	<ul> <li>Precision assembly required</li> <li>Paper fibers may cause problems</li> <li>Cannot print on rough substrates</li> </ul>	• Silverbrook, EP 0771 658 A2 and related patent applications

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Transfer roller	Drops are printed to a transfer	<ul> <li>◆ High accuracy</li> </ul>	•	Bulky	<ul> <li>Silverbrook, EP</li> </ul>
	roller instead of straight to the	<ul> <li>Wide range of print</li> </ul>	•	Expensive	0771 658 A2 and
	print medium. A transfer roller	substrates can be used	•	Complex construction	related patent
	can also be used for proximity	<ul> <li>Ink can be dried on the</li> </ul>			applications
	drop separation	transfer roller			<ul> <li>Tektronix hot melt</li> </ul>
	arch scharacou.				piezoelectric inkjet
					<ul> <li>Any of the IJ series</li> </ul>
Electrostatic	An electric field is used to	<ul> <li>◆ Low power</li> </ul>	•	Field strength required for separation	<ul> <li>Silverbrook, EP</li> </ul>
	accelerate selected drops towards	<ul> <li>Simple print head</li> </ul>		of small drops is near or above air	0771 658 A2 and
	the print medium.	construction		breakdown	related patent
					applications
					◆ Tone-Jet
Direct	A magnetic field is used to	<ul> <li>◆ Low power</li> </ul>	•	Requires magnetic ink	<ul> <li>Silverbrook, EP</li> </ul>
magnetic field	accelerate selected drops of	<ul> <li>Simple print head</li> </ul>	•	Requires strong magnetic field	0771 658 A2 and
	magnetic ink towards the print	construction			related patent
	medium.				applications
2002	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	A Does not require magnetic	•	Demites external marnet	▲ TI0K TI1K
5010	I ne print nead is piaced in a	worthwild to be integrated		Neganics caterina magnet	0107,000
magnetic rield	constant magnetic field. The	materials to be integrated	<b>*</b>	Current densities may be high,	
	Lorenz force in a current carrying	in the print head		resulting in electromigration problems	
	wire is used to move the actuator.	manufacturing process			
Pulsed	A pulsed magnetic field is used to	<ul> <li>Very low power operation</li> </ul>	•	Complex print head construction	◆ IJ10
magnetic field	cyclically attract a paddle, which	is possible	•	Magnetic materials required in print	
	pushes on the ink. A small	<ul> <li>Small print head size</li> </ul>		head	
	actuator moves a catch, which		****		
	selectively prevents the paddle				
	from moving.				

# ACTUATOR AMPLIFICATION OR MODIFICATION METHOD

Actuator amplification	Description	Advantages	Dis	Disadvantages	Examples
None	No actuator mechanical amplification is used. The actuator directly drives the drop ejection process.	Operational simplicity	<b>*</b>	Many actuator mechanisms have insufficient travel, or insufficient force, to efficiently drive the drop ejection process	<ul> <li>Thermal Bubble Inkjet</li> <li>IJ01, IJ02, IJ06, IJ07</li> <li>IJ16, IJ25, IJ26</li> </ul>
Differential expansion bend actuator	An actuator material expands more on one side than on the other. The expansion may be thermal, piezoelectric, magnetostrictive, or other mechanism.	<ul> <li>Provides greater travel in a reduced print head area</li> <li>The bend actuator converts a high force low travel actuator mechanism to high travel, lower force mechanism.</li> </ul>	<b>* * *</b>	High stresses are involved Care must be taken that the materials do not delaminate Residual bend resulting from high temperature or high stress during formation	<ul> <li>Piezoelectric</li> <li>103, 1109, 1117-1124</li> <li>1127, 1129-1139, 1142,</li> <li>1142,</li> <li>1143, 1144</li> </ul>
Transient bend actuator	A trilayer bend actuator where the two outside layers are identical. This cancels bend due to ambient temperature and residual stress. The actuator only responds to transient heating of one side or the other.	<ul> <li>Very good temperature stability</li> <li>High speed, as a new drop can be fired before heat dissipates</li> <li>Cancels residual stress of formation</li> </ul>	• •	High stresses are involved Care must be taken that the materials do not delaminate	• IJ40, IJ41
Actuator stack	A series of thin actuators are stacked. This can be appropriate where actuators require high electric field strength, such as electrostatic and piezoelectric actuators.	<ul> <li>Increased travel</li> <li>Reduced drive voltage</li> </ul>	<b>*</b> *	Increased fabrication complexity Increased possibility of short circuits due to pinholes	<ul> <li>Some piezoelectric ink jets</li> <li>IJ04</li> </ul>

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Multiple	Multiple smaller actuators are	• Increases the force	◆ Actuator forces may not add linearly,	not add linearly,	◆ IJ12, IJ13, IJ18,
actuators	used simultaneously to move the ink. Each actuator need provide only a portion of the force required.	<ul> <li>available from an actuator</li> <li>Multiple actuators can be positioned to control ink flow accurately</li> </ul>	reducing emclency		1)20, 1)28, 1)42, 1)43
Linear Spring	A linear spring is used to transform a motion with small travel and high force into a longer travel, lower force motion.	<ul> <li>Matches low travel         actuator with higher travel         requirements</li> <li>Non-contact method of         motion transformation</li> </ul>	• Requires print head area for the spring	area for the spring	• IJ15
Reverse spring	The actuator loads a spring. When the actuator is turned off, the spring releases. This can reverse the force/distance curve of the actuator to make it compatible with the force/time requirements of the drop ejection.	Better coupling to the ink	<ul> <li>Fabrication complexity</li> <li>High stress in the spring</li> </ul>	ity ring	• IJ05, IJ11
Coiled actuator	A bend actuator is coiled to provide greater travel in a reduced chip area.	<ul> <li>Increases travel</li> <li>Reduces chip area</li> <li>Planar implementations are relatively easy to fabricate.</li> </ul>	• Generally restricted to planar implementations due to extreme fabrication difficulty in other orientations.	to planar to extreme in other	<ul> <li>U17, IJ21, IJ34,</li> <li>IJ35</li> </ul>
Flexure bend actuator	A bend actuator has a small region near the fixture point, which flexes much more readily than the remainder of the actuator. The actuator flexing is effectively converted from an even coiling to an angular bend, resulting in greater travel of the actuator tip.	Simple means of increasing travel of a bend actuator	<ul> <li>Care must be taken not to exceed the elastic limit in the flexure area</li> <li>Stress distribution is very uneven</li> <li>Difficult to accurately model with finite element analysis</li> </ul>	tot to exceed the exure area very uneven y model with its	<ul> <li>IJ10, IJ19, IJ33</li> </ul>

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Gears	Gears can be used to increase	◆ Low force, low travel	•	Moving parts are required	+ IJ13
	travel at the expense of duration.	actuators can be used	•	Several actuator cycles are required	
	Circular gears, rack and pinion,	<ul> <li>Can be fabricated using</li> </ul>	•	More complex drive electronics	
	ratchets, and other gearing	standard surface MEMS	•	Complex construction	
	methods can be used.	processes	<b>*</b>	Friction, friction, and wear are possible	
Catch	The actuator controls a small	<ul> <li>Very low actuator energy</li> </ul>	•	Complex construction	◆ IJ10
	catch. The catch either enables or	<ul> <li>Very small actuator size</li> </ul>	<b>*</b>	Requires external force	
	disables movement of an ink		•	Unsuitable for pigmented inks	
	pusher that is controlled in a bulk				
	manner.				
Buckle plate	A buckle plate can be used to	<ul> <li>Very fast movement</li> </ul>	•	Must stay within elastic limits of the	♦ S. Hirata et al, "An
	change a slow actuator into a fast	achievable	_	materials for long device life	Ink-jet Head",
	motion. It can also convert a high		<b>*</b>	High stresses involved	Proc. IEEE MEMS,
	force, low travel actuator into a		•	Generally high power requirement	Feb. 1996, pp 418-
	high travel, medium force motion.				425. ◆ IJ18, IJ27
Tapered	A tapered magnetic pole can	<ul> <li>Linearizes the magnetic</li> </ul>	•	Complex construction	◆ IJ14
magnetic pole	increase travel at the expense of	force/distance curve			
	force.				
Lever	A lever and fulcrum is used to	<ul> <li>Matches low travel</li> </ul>	[ •	High stress around the fulcrum	<ul> <li>1J32, IJ36, IJ37</li> </ul>
	transform a motion with small	actuator with higher travel			
	travel and high force into a	requirements			
	motion with longer travel and	♦ Fulcrum area has no linear			
	lower force. The lever can also	movement, and can be used for a fluid seal			
	reverse the direction of travel.	101 a 1141 a 101 a			

Rotary	The actuator is connected to a	♦ High mechanical	• Compl	Complex construction	•	1J28
	rotary impeller. A small angular deflection of the actuator results in a rotation of the impeller vanes, which push the ink against stationary vanes and out of the nozzle.	The ratio of force to travel of the actuator can be matched to the nozzle requirements by varying the number of impeller vanes	Onsur •	Unsultable for pigmented inks		
Acoustic lens	A refractive or diffractive (e.g. zone plate) acoustic lens is used to	<ul> <li>No moving parts</li> </ul>	<ul><li>Large :</li><li>Only re</li></ul>	Large area required Only relevant for acoustic ink jets	<b>+</b>	1993 Hadimioglu et al, EUP 550,192
	concentrate sound waves.		•		<b>+</b>	1993 Elrod et al, EUP 572,220
Sharp conductive	A sharp point is used to concentrate an electrostatic field.	• Simple construction	• Difficu VLSI p	Difficult to fabricate using standard VLSI processes for a surface ejecting	•	Tone-jet
			Only re	Only relevant for electrostatic ink jets		

# ACTUATOR MOTION

Actuator motion	Description	Advantages	Disa	Disadvantages	Examples
Volume expansion	The volume of the actuator changes, pushing the ink in all directions.	• Simple construction in the case of thermal ink jet	◆ H & ₹ % :-	High energy is typically required to achieve volume expansion. This leads to thermal stress, cavitation, and kogation in thermal ink jet	<ul> <li>Hewlett-Packard         Thermal Inkjet     </li> <li>Canon Bubblejet</li> </ul>
Linear, normal to chip surface	The actuator moves in a direction normal to the print head surface. The nozzle is typically in the line of movement.	Efficient coupling to ink drops ejected normal to the surface	<b>+</b>	High fabrication complexity may be required to achieve perpendicular motion	<ul> <li>IJ01, IJ02, IJ04,</li> <li>IJ07</li> <li>IJ11, IJ14</li> </ul>
Linear, parallel to chip surface	The actuator moves parallel to the print head surface. Drop ejection may still be normal to the surface.	Suitable for planar fabrication	* * *	Fabrication complexity Friction Stiction	<ul> <li>₩ 112, 1113, 1115,</li> <li>₩ 133,</li> <li>₩ 1134, 1135, 1136</li> </ul>
Membrane push	An actuator with a high force but small area is used to push a stiff membrane that is in contact with the ink.	<ul> <li>The effective area of the actuator becomes the membrane area</li> </ul>	+ + +	Fabrication complexity Actuator size Difficulty of integration in a VLSI process	• 1982 Howkins USP 4,459,601
Rotary	The actuator causes the rotation of some element, such a grill or impeller	<ul> <li>Rotary levers may be used to increase travel</li> <li>Small chip area requirements</li> </ul>	1 + +	Device complexity May have friction at a pivot point	<ul> <li>IJ05, IJ08, IJ13,</li> <li>IJ28</li> </ul>

Bond	The contractor leaders of	◆ A very small change in	A Requires the actuator to be made from	◆ 1970 Kyger et al
	ine actuator ocinos when	dimensions can be	at least two distinct layers, or to have	USP 3,946,398
	differential thermal expansion,	converted to a large	a thermal difference across the	◆ 1973 Stemme USP
	piezoelectric expansion,	motion.	actuator	3,747,120
	magnetostriction, or other form of			◆ IJ03, IJ09, IJ10,
	relative dimensional change.			6101
		•		• IJ23, IJ24, IJ25,
				177A
				◆ IJ30, IJ31, IJ33,
				134
Swivel	The actuator swivels around a	<ul> <li>♦ Allows operation where</li> </ul>	◆ Inefficient coupling to the ink motion	◆ IJ06
	central pivot. This motion is	the net linear force on the		
	suitable where there are opposite	paddle is zero		
	forces applied to opposite sides of	<ul> <li>Small chip area</li> </ul>		
	the paddle, e.g. Lorenz force.	requirements		
Straighten	The actuator is normally bent, and	<ul> <li>Can be used with shape</li> </ul>	<ul> <li>◆ Requires careful balance of stresses to</li> </ul>	<ul> <li>IJ26, IJ32</li> </ul>
	straightens when energized.	memory alloys where the	ensure that the quiescent bend is	
		austenic phase is planar	accurate	
Double bend	The actuator bends in one	<ul> <li>One actuator can be</li> </ul>	<ul> <li>Difficult to make the drops</li> </ul>	<ul> <li>◆ IJ36, IJ37, IJ38</li> </ul>
	direction when one element is	used to power two	ejected by both bend directions	
	energized, and bends the other	nozzles.	identical.	
	way when another element is	<ul> <li>Reduced chip size.</li> </ul>	<ul> <li>A small efficiency loss compared</li> </ul>	
	energized.	<ul> <li>Not sensitive to ambient temperature</li> </ul>	to equivalent single bend actuators.	
Shear	Energizing the actuator causes a	◆ Can increase the	<ul> <li>Not readily applicable to other</li> </ul>	♦ 1985 Fishbeck
	shear motion in the actuator	effective travel of	actuator mechanisms	USP 4,584,590
	material.	piezoelectric actuators		
Radial	The actuator squeezes an ink	<ul> <li>♠ Relatively easy to</li> </ul>	◆ High force required	• 1970 Zoltan
constriction	reservoir, forcing ink from a	fabricate single	<ul><li>◆ Inefficient</li></ul>	USP 3,683,212
	constricted nozzle.	nozzles from glass tubing as macroscopic	<ul> <li>Difficult to integrate with VLSI processes</li> </ul>	
		structures		

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Coil / uncoil	A coiled actuator uncoils or coils more tightly. The motion of the free end of the actuator ejects the ink.	<ul> <li>Easy to fabricate as a planar VLSI process</li> <li>Small area required, therefore low cost</li> </ul>	<ul> <li>Difficult to fabricate for non-planar devices</li> <li>Poor out-of-plane stiffness</li> </ul>	+ IJ17, IJ21, IJ34, IJ35
Bow	The actuator bows (or buckles) in the middle when energized.	<ul><li>Can increase the speed of travel</li><li>Mechanically rigid</li></ul>	<ul> <li>Maximum travel is constrained</li> <li>High force required</li> </ul>	<ul> <li>U16, U18, U27</li> </ul>
Push-Pull	Two actuators control a shutter. One actuator pulls the shutter, and the other pushes it.	• The structure is pinned at both ends, so has a high out-of-plane rigidity	<ul> <li>Not readily suitable for inkjets which directly push the ink</li> </ul>	• IJ18
Curl inwards	A set of actuators curl inwards to reduce the volume of ink that they enclose.	• Good fluid flow to the region behind the actuator increases efficiency	Design complexity	<ul> <li>IJ20, IJ42</li> </ul>
Curl outwards	A set of actuators curl outwards, pressurizing ink in a chamber surrounding the actuators, and expelling ink from a nozzle in the chamber.	• Relatively simple construction	• Relatively large chip area	• IJ43
Iris	Multiple vanes enclose a volume of ink. These simultaneously rotate, reducing the volume between the vanes.	<ul><li>High efficiency</li><li>Small chip area</li></ul>	<ul> <li>High fabrication complexity</li> <li>Not suitable for pigmented inks</li> </ul>	• IJ22
Acoustic vibration	The actuator vibrates at a high frequency.	<ul> <li>The actuator can be physically distant from the ink</li> </ul>	<ul> <li>Large area required for efficient operation at useful frequencies</li> <li>Acoustic coupling and crosstalk</li> <li>Complex drive circuitry</li> <li>Poor control of drop volume and position</li> </ul>	<ul> <li>1993</li> <li>Hadimioglu et al, EUP 550,192</li> <li>1993 Elrod et al, EUP 572,220</li> </ul>

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None	In various ink jet designs the	<ul> <li>♦ No moving parts</li> </ul>	◆ Various other tradeoffs are required to ◆	<ul> <li>Silverbrook, EP</li> </ul>
	actuator does not move.		eliminate moving parts	0771 658 A2 and
				related patent
				applications
				◆ Tone-jet

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# Nozzle Refill Method

Nozzle refill method	Description	Advantages	Disadvantages	Examples
Surface tension	After the actuator is energized, it typically returns rapidly to its normal position. This rapid return sucks in air through the nozzle opening. The ink surface tension at the nozzle then exerts a small force restoring the meniscus to a minimum area.	<ul> <li>Fabrication simplicity</li> <li>Operational simplicity</li> </ul>	<ul> <li>Low speed</li> <li>Surface tension force relatively small compared to actuator force</li> <li>Long refill time usually dominates the total repetition rate</li> </ul>	<ul> <li>Thermal inkjet</li> <li>Piezoelectric inkjet</li> <li>IJ01-IJ07, IJ10-IJ14</li> <li>IJ16, IJ20, IJ22-IJ45</li> </ul>
Shuttered oscillating ink pressure	Ink to the nozzle chamber is provided at a pressure that oscillates at twice the drop ejection frequency. When a drop is to be ejected, the shutter is opened for 3 half cycles: drop ejection, actuator return, and refill.	<ul> <li>High speed</li> <li>Low actuator energy, as the actuator need only open or close the shutter, instead of ejecting the ink drop</li> </ul>	<ul> <li>Requires common ink pressure oscillator</li> <li>May not be suitable for pigmented inks</li> </ul>	<ul> <li>108, 1113, 1115,</li> <li>1117</li> <li>1118, 1119, 1121</li> </ul>
Refill actuator	After the main actuator has ejected a drop a second (refill) actuator is energized. The refill actuator pushes ink into the nozzle chamber. The refill actuator returns slowly, to prevent its return from emptying the chamber again.	<ul> <li>High speed, as the nozzle is actively refilled</li> </ul>	<ul> <li>Requires two independent actuators per nozzle</li> </ul>	• . 1J09

Positive ink	The ink is held a slight positive	◆ High refill rate, therefore a ◆ Surface spill must be prevented	<ul> <li>Surface spill must be pr</li> </ul>	revented	◆ Silverbrook, EP
pressure	pressure. After the ink drop is	high drop repetition rate is	<ul> <li>Highly hydrophobic print head</li> </ul>	int head	0771 658 A2 and
	ejected, the nozzle chamber fills	possible	surfaces are required		related patent
	quickly as surface tension and ink				applications
	pressure both onerate to refill the				<ul> <li>Alternative for:</li> </ul>
	nozzle				◆ IJ01-IJ07, IJ10-IJ14
					◆ IJ16, IJ20, IJ22-IJ45

# METHOD OF RESTRICTING BACK-FLOW THROUGH INLET

Inlet back-flow restriction method	Description	Advantages	Disadvantages	Examples
Long inlet channel	The ink inlet channel to the nozzle chamber is made long and relatively narrow, relying on viscous drag to reduce inlet backflow.	<ul> <li>Design simplicity</li> <li>Operational simplicity</li> <li>Reduces crosstalk</li> </ul>	<ul> <li>Restricts refill rate</li> <li>May result in a relatively large chip area</li> <li>Only partially effective</li> </ul>	<ul> <li>Thermal inkjet</li> <li>Piezoelectric inkjet</li> <li>IJ42, IJ43</li> </ul>
Positive ink pressure	The ink is under a positive pressure, so that in the quiescent state some of the ink drop already protrudes from the nozzle.  This reduces the pressure in the nozzle chamber which is required to eject a certain volume of ink.  The reduction in chamber pressure results in a reduction in ink pushed out through the inlet.	<ul> <li>Drop selection and separation forces can be reduced</li> <li>Fast refill time</li> </ul>	• Requires a method (such as a nozzle rim or effective hydrophobizing, or both) to prevent flooding of the ejection surface of the print head.	<ul> <li>Silverbrook, EP 0771 658 A2 and related patent applications</li> <li>Possible operation of the following:         <ul> <li>101-1107, 1109-1112</li> <li>1114, 1116, 1120, 1122</li> <li>1122</li> <li>1123-1134, 1136-1144</li> </ul> </li> </ul>

Baffle	One or more baffles are placed in the inlet ink flow. When the actuator is energized, the rapid ink movement creates eddies which restrict the flow through the inlet. The slower refill process is unrestricted, and does not result in eddies.	<ul> <li>The refill rate is not as restricted as the long inlet method.</li> <li>Reduces crosstalk</li> </ul>	<ul> <li>Design complexity</li> <li>May increase fabrication complexity (e.g. Tektronix hot melt Piezoelectric print heads).</li> </ul>	<ul> <li>HP Thermal Ink Jet  Tektronix piezoelectric ink jet</li> </ul>
Flexible flap restricts inlet	In this method recently disclosed by Canon, the expanding actuator (bubble) pushes on a flexible flap that restricts the inlet.	<ul> <li>Significantly reduces back-flow for edge- shooter thermal ink jet devices</li> </ul>	<ul> <li>Not applicable to most inkjet configurations</li> <li>Increased fabrication complexity</li> <li>Inelastic deformation of polymer flap results in creep over extended use</li> </ul>	• Canon
Inlet filter	A filter is located between the ink inlet and the nozzle chamber. The filter has a multitude of small holes or slots, restricting ink flow. The filter also removes particles which may block the nozzle.	<ul> <li>Additional advantage of ink filtration</li> <li>Ink filter may be fabricated with no additional process steps</li> </ul>	<ul> <li>Restricts refill rate</li> <li>May result in complex construction</li> </ul>	<ul> <li>104, 1012, 1024,</li> <li>1027</li> <li>1029, 1030</li> </ul>
Small inlet compared to nozzle	The ink inlet channel to the nozzle chamber has a substantially smaller cross section than that of the nozzle, resulting in easier ink egress out of the nozzle than out of the inlet.	• Design simplicity	<ul> <li>Restricts refill rate</li> <li>May result in a relatively large chip area</li> <li>Only partially effective</li> </ul>	<ul> <li>102, 137, 134</li> </ul>
Inlet shutter	A secondary actuator controls the position of a shutter, closing off the ink inlet when the main actuator is energized.	<ul> <li>Increases speed of the ink- jet print head operation</li> </ul>	<ul> <li>Requires separate refill actuator and drive circuit</li> </ul>	<ul><li>↓ IJ09</li></ul>

The inlet is located behind	The method avoids the problem of inlet back-flow by arranging the	<ul> <li>Back-flow problem is eliminated</li> </ul>	◆ R 43	Requires careful design to minimize the negative pressure behind the	♦ IJ01, IJ03, IJ05, IJ06
the ink- pushing	inco cach from 57 minishing incline in the inlet and the		<u>,</u>	paddle	• 1J07, IJ10, IJ11, IJ14
surface	nozzle.				◆ IJ16, IJ22, IJ23, IT25
					• 1128, 1131, 1132, 1133
					• 1134, 1135, 1136,
					◆ IJ40, IJ41
Part of the actuator	The actuator and a wall of the ink chamber are arranged so that the	Significant reductions in back-flow can be achieved	÷	Small increase in fabrication complexity	• 1107, 1120, 1126, 1138
off the inlet	motion of the actuator closes off the inlet.	<ul> <li>Compact designs possible</li> </ul>			
Nozzle actuator does	In some configurations of ink jet,	<ul> <li>♦ Ink back-flow problem is eliminated</li> </ul>	◆ S	None related to ink back-flow on actuation	◆ Silverbrook, EP 0771 658 A2 and
not result in	movement of an actuator which				related patent
IIIN DACK-110W	may cause ink back-flow through				<ul><li>applications</li><li>Valve-jet</li></ul>
					◆ Tone-jet
					<ul> <li>◆ IJ08, IJ13, IJ15,</li> </ul>
					IJ17
					<ul> <li>◆ IJ18, IJ19, IJ21</li> </ul>

# Nozzle Clearing Method

Nozzle Clearing method	Description	Advantages	Disadvantages	Examples
Normal nozzle firing	All of the nozzles are fired periodically, before the ink has a chance to dry. When not in use the nozzles are sealed (capped) against air.  The nozzle firing is usually performed during a special clearing cycle, after first moving the print head to a cleaning station.	<ul> <li>No added complexity on the print head</li> </ul>	<ul> <li>May not be sufficient to displace dried ink</li> </ul>	<ul> <li>Most ink jet systems</li> <li>IJ01- IJ07, IJ09-IJ12</li> <li>IJ14, IJ16, IJ20, IJ22</li> <li>IJ23- IJ34, IJ36-IJ45</li> </ul>
Extra power to ink heater	In systems which heat the ink, but do not boil it under normal situations, nozzle clearing can be achieved by over-powering the heater and boiling ink at the nozzle.	<ul> <li>Can be highly effective if the heater is adjacent to the nozzle</li> </ul>	<ul> <li>Requires higher drive voltage for clearing</li> <li>May require larger drive transistors</li> </ul>	• Silverbrook, EP 0771 658 A2 and related patent applications
Rapid succession of actuator pulses	The actuator is fired in rapid succession. In some configurations, this may cause heat build-up at the nozzle which boils the ink, clearing the nozzle. In other situations, it may cause sufficient vibrations to dislodge clogged nozzles.	<ul> <li>Does not require extra drive circuits on the print head</li> <li>Can be readily controlled and initiated by digital logic</li> </ul>	<ul> <li>Effectiveness depends substantially upon the configuration of the inkjet nozzle</li> </ul>	<ul> <li>May be used with:</li> <li>1101-1107, 1109-1111</li> <li>1114, 1116, 1120, 1122</li> <li>1123-1125, 1127-1134</li> <li>1136-1145</li> </ul>

Extra power to ink pushing actuator	Where an actuator is not normally driven to the limit of its motion, nozzle clearing may be assisted by providing an enhanced drive signal to the actuator.	• A simple solution where applicable	<ul> <li>Not suitable where there is a hard limit to actuator movement</li> </ul>	<ul> <li>May be used with:</li> <li>103, 1109, 1116, 1120</li> <li>1123, 1124, 1125, 1127</li> <li>1129, 1130, 1131, 1132</li> <li>1132</li> <li>1139, 1140, 1141, 1142</li> <li>1142</li> <li>1142</li> <li>1143, 1144, 1145</li> </ul>
Acoustic resonance	An ultrasonic wave is applied to the ink chamber. This wave is of an appropriate amplitude and frequency to cause sufficient force at the nozzle to clear blockages. This is easiest to achieve if the ultrasonic wave is at a resonant frequency of the ink cavity.	<ul> <li>A high nozzle clearing capability can be achieved</li> <li>May be implemented at very low cost in systems which already include acoustic actuators</li> </ul>	<ul> <li>High implementation cost if system does not already include an acoustic actuator</li> </ul>	<ul> <li>108, 1113, 1115, 1117</li> <li>1118, 1119, 1121</li> </ul>
Nozzle clearing plate	A microfabricated plate is pushed against the nozzles. The plate has a post for every nozzle. The array of posts	<ul> <li>Can clear severely clogged nozzles</li> </ul>	<ul> <li>Accurate mechanical alignment is required</li> <li>Moving parts are required</li> <li>There is risk of damage to the nozzles</li> <li>Accurate fabrication is required</li> </ul>	<ul> <li>Silverbrook, EP 0771 658 A2 and related patent applications</li> </ul>
Ink pressure pulse	The pressure of the ink is temporarily increased so that ink streams from all of the nozzles. This may be used in conjunction with actuator energizing.	<ul> <li>May be effective where other methods cannot be used</li> </ul>	<ul> <li>Requires pressure pump or other pressure actuator</li> <li>Expensive</li> <li>Wasteful of ink</li> </ul>	• May be used with all IJ series ink jets

Print head wiper	A flexible 'blade' is wiped across the print head surface. The blade is usually fabricated from a flexible polymer, e.g. rubber or synthetic elastomer.	<ul> <li>Effective for planar print head surfaces</li> <li>Low cost</li> </ul>	<b>* * *</b>	Difficult to use if print head surface is onn-planar or very fragile systems Requires mechanical parts Blade can wear out in high volume print systems	<b>♦</b>	Many ink jet systems
Separate ink boiling heater	A separate heater is provided at the nozzle although the normal drop e-ection mechanism does not require it. The heaters do not require individual drive circuits, as many nozzles can be cleared simultaneously, and no imaging is required.	<ul> <li>Can be effective where other nozzle clearing methods cannot be used</li> <li>Can be implemented at no additional cost in some inkjet configurations</li> </ul>	<b>•</b>	Fabrication complexity	<u> </u>	Can be used with many IJ series ink jets

# NOZZLE PLATE CONSTRUCTION

Nozzle plate construction	Description	Advantages	Disa	Disadvantages	Examples
Electroformed nickel	A nozzle plate is separately fabricated from electroformed nickel, and bonded to the print head chip.	<ul> <li>Fabrication simplicity</li> </ul>	* * *	High temperatures and pressures are required to bond nozzle plate Minimum thickness constraints Differential thermal expansion	<ul> <li>Hewlett Packard</li> <li>Thermal Inkjet</li> </ul>
Laser ablated or drilled polymer	Individual nozzle holes are ablated by an intense UV laser in a nozzle plate, which is typically a polymer such as polyimide or polysulphone	<ul> <li>No masks required</li> <li>Can be quite fast</li> <li>Some control over nozzle profile is possible</li> <li>Equipment required is relatively low cost</li> </ul>	* * * *	Each hole must be individually formed Special equipment required Slow where there are many thousands of nozzles per print head May produce thin burrs at exit holes	<ul> <li>Canon Bubblejet</li> <li>1988 Sercel et al.,</li> <li>SPIE, Vol. 998</li> <li>Excimer Beam</li> <li>Applications, pp.</li> <li>76-83</li> <li>1993 Watanabe et al., USP 5,208,604</li> </ul>
Silicon micro- machined	A separate nozzle plate is micromachined from single crystal silicon, and bonded to the print head wafer.	<ul> <li>High accuracy is attainable</li> </ul>	+ + + + H H Z	Two part construction High cost Requires precision alignment Nozzles may be clogged by adhesive	<ul> <li>K. Bean, IEEE         Transactions on             Electron Devices,             Vol. ED-25, No. 10,             1978, pp 1185-1195             Xerox 1990             Hawkins et al., USP             4,899,181</li> </ul>
Glass capillaries	Fine glass capillaries are drawn from glass tubing. This method has been used for making individual nozzles, but is difficult to use for bulk manufacturing of print heads with thousands of nozzles.	<ul> <li>No expensive equipment required</li> <li>Simple to make single nozzles</li> </ul>	◆     ◆       > 3 Z	Very small nozzle sizes are difficult to form  Not suited for mass production	• 1970 Zoltan USP 3,683,212

Monolithic, surface micro-	The nozzle plate is deposited as a layer using standard VLSI	<ul> <li>High accuracy (&lt;1 μm)</li> <li>Monolithic</li> </ul>	•	Requires sacrificial layer under the nozzle plate to form the nozzle chamber	Silverbrook, EP     0771 658 A2 and related patent
using VLSI	are etched in the nozzle plate	► Low cost  Existing processes can be	•	Surface may be fragile to the touch	applications
lithographic processes	using VLSI lithography and	nsed			• IJ01, IJ02, IJ04, IJ11
	ciciiiig.				• IJ12, IJ17, IJ18, IJ20
					<ul> <li>IJ22, IJ24, IJ27,</li> <li>IJ28</li> </ul>
					• 1J29, IJ30, IJ31, IJ32
					<ul> <li>IJ33, IJ34, IJ36,</li> <li>IJ37</li> </ul>
					◆ IJ38, IJ39, IJ40, IJ41
					◆ IJ42, IJ43, IJ44
Monolithic,	The nozzle plate is a buried etch	<ul> <li>High accuracy (&lt;1 μm)</li> </ul>	•	Requires long etch times	◆ IJ03, IJ05, IJ06,
etched	stop in the wafer. Nozzle	• Monolithic	<b>*</b>	Requires a support wafer	1.007 TOO TOO
substrate	chambers are etched in the front of the wafer, and the wafer is	<ul><li>Low cost</li><li>No differential expansion</li></ul>	•		• 1308, 1309, 1310,
	thinned from the back side.	•			• IJ14, IJ15, IJ16, IJ19
	etch stop layer.				• 1J21, 1J23, 1J25, 1J26
No nozzle	Various methods have been tried	No nozzles to become	•	Difficult to control drop position	• Ricoh 1995 Sekiya
plate	to eliminate the nozzles entirely, to prevent nozzle closeing. These	clogged	•	accurately Crosstalk problems	et al USP 5,412,413 • 1993 Hadimioglu et
	include thermal bubble				al EUP 550,192
	mechanisms and acoustic lens		•		• 1993 Elrod et al
	mechanisms				EUF 3/2,220

Trough	Each drop ejector has a trough through which a paddle moves. There is no nozzle plate.	<ul> <li>Reduced manufacturing complexity</li> <li>Monolithic</li> </ul>	<ul> <li>Drop firing direction is sensitive to wicking.</li> </ul>	• IJ35
Nozzle slit instead of individual nozzles	The elimination of nozzle holes and replacement by a slit encompassing many actuator positions reduces nozzle clogging, but increases crosstalk due to ink surface waves	◆ No nozzles to become clogged	<ul> <li>Difficult to control drop position accurately</li> <li>Crosstalk problems</li> </ul>	• 1989 Saito et al USP 4,799,068

# **DROP EJECTION DIRECTION**

Ejection direction	Description	Advantages	Disadvantages	Examples
Edge ('edge shooter')	Ink flow is along the surface of the chip, and ink drops are ejected from the chip edge.	<ul> <li>Simple construction</li> <li>No silicon etching required</li> <li>Good heat sinking via substrate</li> <li>Mechanically strong</li> <li>Ease of chip handing</li> </ul>	<ul> <li>Nozzles limited to edge</li> <li>High resolution is difficult</li> <li>Fast color printing requires one print head per color</li> </ul>	<ul> <li>Canon Bubblejet 1979 Endo et al GB patent 2,007,162</li> <li>Xerox heater-in- pit 1990 Hawkins et al USP 4,899,181</li> <li>Tone-jet</li> </ul>
Surface ('roof shooter')	Ink flow is along the surface of the chip, and ink drops are ejected from the chip surface, normal to the plane of the chip.	<ul> <li>No bulk silicon etching required</li> <li>Silicon can make an effective heat sink</li> <li>Mechanical strength</li> </ul>	<ul> <li>Maximum ink flow is severely restricted</li> </ul>	<ul> <li>Hewlett- Packard TIJ 1982 Vaught et al USP 4,490,728</li> <li>IJ02, IJ11, IJ12, IJ20</li> <li>IJ22</li> </ul>
Through chip, forward ('up shooter')	Ink flow is through the chip, and ink drops are ejected from the front surface of the chip.	<ul> <li>High ink flow</li> <li>Suitable for pagewidth print</li> <li>High nozzle packing density therefore low manufacturing cost</li> </ul>	<ul> <li>Requires bulk silicon etching</li> </ul>	<ul> <li>Silverbrook, EP 0771 658 A2 and related patent applications</li> <li>IJ04, IJ17, IJ18, IJ24</li> <li>IJ27-IJ45</li> </ul>

Through chip,	Ink flow is through the chip, and	♦ High ink flow	• Requires wafer thinning	• IJ01, IJ03, IJ05,
reverse ('down	ink drops are ejected from the rear surface of the chip.	<ul> <li>Suitable for pagewidth</li> <li>print</li> </ul>	<ul> <li>Kequires special nandling during manufacture</li> </ul>	• 1107, 1108, 1109,
shooter")		<ul> <li>High nozzle packing</li> </ul>		1310
		density therefore low manufacturing cost		• 1J13, 1J14, 1J15, 1J16
				<ul> <li>◆ IJ19, IJ21, IJ23,</li> </ul>
				1125
				<ul> <li>◆ IJ26</li> </ul>
Through	Ink flow is through the actuator,	<ul><li>Suitable for</li></ul>	<ul> <li>Pagewidth print heads require</li> </ul>	<ul> <li>Epson Stylus</li> </ul>
actuator	which is not fabricated as part of	piezoelectric print	several thousand connections to	<ul> <li>Tektronix hot</li> </ul>
_	the same substrate as the drive	heads	drive circuits	melt
	transistors		<ul> <li>Cannot be manufactured in</li> </ul>	piezoelectric ink
			standard CMOS fabs	jets
			<ul> <li>Complex assembly required</li> </ul>	

# INK TYPE

Ink type	Description	Advantages	Disadvantages	Examples
Aqueous, dye	Water based ink which typically contains: water, dye, surfactant, humectant, and biocide.  Modern ink dyes have high waterfastness, light fastness	<ul> <li>Environmentally friendly</li> <li>No odor</li> </ul>	<ul> <li>Slow drying</li> <li>Corrosive</li> <li>Bleeds on paper</li> <li>May strikethrough</li> <li>Cockles paper</li> </ul>	<ul> <li>Most existing inkjets</li> <li>All IJ series ink jets</li> <li>Silverbrook, EP 0771 658 A2 and related patent applications</li> </ul>
Aqueous, pigment	Water based ink which typically contains: water, pigment, surfactant, humectant, and biocide.  Pigments have an advantage in reduced bleed, wicking and strikethrough.	<ul> <li>Environmentally friendly</li> <li>No odor</li> <li>Reduced bleed</li> <li>Reduced wicking</li> <li>Reduced strikethrough</li> </ul>	<ul> <li>Slow drying</li> <li>Corrosive</li> <li>Pigment may clog nozzles</li> <li>Pigment may clog actuator mechanisms</li> <li>Cockles paper</li> </ul>	<ul> <li>IJ02, IJ04, IJ21, IJ26</li> <li>IJ27, IJ30</li> <li>Silverbrook, EP 0771 658 A2 and related patent applications</li> <li>Piezoelectric inkjets</li> <li>Thermal ink jets (with significant restrictions)</li> </ul>
Methyl Ethyl Ketone (MEK)	MEK is a highly volatile solvent used for industrial printing on difficult surfaces such as aluminum cans.	<ul> <li>Very fast drying</li> <li>Prints on various substrates such as metals and plastics</li> </ul>	<ul><li>Odorous</li><li>Flammable</li></ul>	<ul> <li>All IJ series ink jets</li> </ul>

Alcohol	Alcohol based inks can be used	<ul> <li>Fast drying</li> </ul>	•	Slight odor	<b>→</b>	All IJ series ink jets
(ethanol, 2-	where the printer must operate at	<ul> <li>Operates at sub-freezing</li> </ul>	•	Flammable	<u></u>	
butanol, and	temperatures below the freezing	temperatures				
others)	point of water. An example of this	<ul> <li>Reduced paper cockle</li> </ul>				
	is in-camera consumer	<ul><li>Low cost</li></ul>				
	photographic printing.					
Phase change	The ink is solid at room	<ul> <li>No drying time- ink</li> </ul>	•	High viscosity	•	Tektronix hot melt
(hot melt)	temperature, and is melted in the	instantly freezes on the	•	Printed ink typically has a 'waxy' feel	<u>p.</u> ,	piezoelectric ink jets
	print head before jetting. Hot melt	print medium	•	Printed pages may 'block'	<b>•</b>	1989 Nowak USP
	inks are usually wax based, with a	<ul> <li>Almost any print medium</li> </ul>	•	Ink temperature may be above the	4	4,820,346
	melting point around 80 °C. After	can be used		curie point of permanent magnets	<b>√</b>	All IJ series ink jets
	ietting the ink freezes almost	<ul> <li>No paper cockle occurs</li> </ul>	•	Ink heaters consume power		
	instantly upon contacting the print	<ul> <li>No wicking occurs</li> </ul>	•	Long warm-up time		
	medium or a transfer roller.	<ul> <li>No bleed occurs</li> </ul>		,		
		<ul> <li>No strikethrough occurs</li> </ul>			1	
lio	Oil based inks are extensively	<ul> <li>High solubility medium</li> </ul>	•	High viscosity: this is a significant	<b>+</b>	All IJ series ink jets
	used in offset printing. They have	for some dyes		limitation for use in inkjets, which		
	advantages in improved	<ul> <li>Does not cockle paper</li> </ul>		usually require a low viscosity. Some		
	characteristics on paper	<ul> <li>Does not wick through</li> </ul>		short chain and multi-branched oils		
	(especially no wicking or cockle).	paper		have a sufficiently low viscosity.		
	Oil soluble dies and pigments are		•	Slow drying		
	required.					
Microemulsion	A microemulsion is a stable, self	<ul> <li>Stops ink bleed</li> </ul>	•	Viscosity higher than water	+	All IJ series ink jets
-	forming emulsion of oil, water,	<ul> <li>High dye solubility</li> </ul>	•	Cost is slightly higher than water		
	and surfactant. The characteristic	<ul><li>Water, oil, and</li></ul>		based ink		
	drop size is less than 100 nm, and	amphiphilic soluble dies	•	High surfactant concentration		
	is determined by the preferred	can be used		required (around 5%)		
	curvature of the surfactant.	<ul> <li>Can stabilize pigment suspensions</li> </ul>				
		cupromodens	4			

## **Ink Jet Printing**

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A large number of new forms of ink jet printers have been developed to facilitate alternative ink jet technologies for the image processing and data distribution system. Various combinations of ink jet devices can be included in printer devices incorporated as part of the present invention. Australian Provisional Patent Applications relating to these ink jets which are specifically incorporated by cross reference include:

Provisional Number  PO8066 15-Jul-97 Image Creation Method and Apparatus (IJ01)  PO8072 15-Jul-97 Image Creation Method and Apparatus (IJ02)  PO8040 15-Jul-97 Image Creation Method and Apparatus (IJ03)  PO8071 15-Jul-97 Image Creation Method and Apparatus (IJ04)  PO8047 15-Jul-97 Image Creation Method and Apparatus (IJ05)  PO8035 15-Jul-97 Image Creation Method and Apparatus (IJ06)  PO8044 15-Jul-97 Image Creation Method and Apparatus (IJ07)  PO8063 15-Jul-97 Image Creation Method and Apparatus (IJ08)  PO8057 15-Jul-97 Image Creation Method and Apparatus (IJ08)  PO8056 15-Jul-97 Image Creation Method and Apparatus (IJ10)  PO8069 15-Jul-97 Image Creation Method and Apparatus (IJ11)  PO8049 15-Jul-97 Image Creation Method and Apparatus (IJ12)  PO8036 15-Jul-97 Image Creation Method and Apparatus (IJ13)  PO8048 15-Jul-97 Image Creation Method and Apparatus (IJ14)  PO8070 15-Jul-97 Image Creation Method and Apparatus (IJ15)  PO8067 15-Jul-97 Image Creation Method and Apparatus (IJ16)  PO8001 15-Jul-97 Image Creation Method and Apparatus (IJ17)  PO8033 15-Jul-97 Image Creation Method and Apparatus (IJ18)  PO8002 15-Jul-97 Image Creation Method and Apparatus (IJ19)  PO8068 15-Jul-97 Image Creation Method and Apparatus (IJ20)  PO8062 15-Jul-97 Image Creation Method and Apparatus (IJ20)	Australian	Eiling Data	Title
PO8066         15-Jul-97         Image Creation Method and Apparatus (IJ01)           PO8072         15-Jul-97         Image Creation Method and Apparatus (IJ02)           PO8040         15-Jul-97         Image Creation Method and Apparatus (IJ03)           PO8071         15-Jul-97         Image Creation Method and Apparatus (IJ04)           PO8047         15-Jul-97         Image Creation Method and Apparatus (IJ06)           PO8035         15-Jul-97         Image Creation Method and Apparatus (IJ07)           PO8064         15-Jul-97         Image Creation Method and Apparatus (IJ08)           PO8057         15-Jul-97         Image Creation Method and Apparatus (IJ09)           PO8056         15-Jul-97         Image Creation Method and Apparatus (IJ10)           PO8069         15-Jul-97         Image Creation Method and Apparatus (IJ11)           PO8049         15-Jul-97         Image Creation Method and Apparatus (IJ12)           PO8049         15-Jul-97         Image Creation Method and Apparatus (IJ13)           PO8040         15-Jul-97         Image Creation Method and Apparatus (IJ14)           PO8070         15-Jul-97         Image Creation Method and Apparatus (IJ15)           PO8067         15-Jul-97         Image Creation Method and Apparatus (IJ17)           PO8033         15-Jul-97         Image Creation Method	Provisional	Filing Date	Title
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PO8062 15-Jul-97 Image Creation Method and Apparatus (IJ22) PO8034 15-Jul-97 Image Creation Method and Apparatus (IJ23) PO8039 15-Jul-97 Image Creation Method and Apparatus (IJ24) PO8041 15-Jul-97 Image Creation Method and Apparatus (IJ25) PO8004 15-Jul-97 Image Creation Method and Apparatus (IJ26) PO8037 15-Jul-97 Image Creation Method and Apparatus (IJ27)	PO8002	15-Jul-97	Image Creation Method and Apparatus (IJ20)
PO8034 15-Jul-97 Image Creation Method and Apparatus (IJ23) PO8039 15-Jul-97 Image Creation Method and Apparatus (IJ24) PO8041 15-Jul-97 Image Creation Method and Apparatus (IJ25) PO8004 15-Jul-97 Image Creation Method and Apparatus (IJ26) PO8037 15-Jul-97 Image Creation Method and Apparatus (IJ27)	PO8068	15-Jul-97	Image Creation Method and Apparatus (IJ21)
PO8039 15-Jul-97 Image Creation Method and Apparatus (IJ24) PO8041 15-Jul-97 Image Creation Method and Apparatus (IJ25) PO8004 15-Jul-97 Image Creation Method and Apparatus (IJ26) PO8037 15-Jul-97 Image Creation Method and Apparatus (IJ27)	PO8062	15-Jul-97	Image Creation Method and Apparatus (IJ22)
PO8041 15-Jul-97 Image Creation Method and Apparatus (IJ25) PO8004 15-Jul-97 Image Creation Method and Apparatus (IJ26) PO8037 15-Jul-97 Image Creation Method and Apparatus (IJ27)	PO8034	15-Jul-97	Image Creation Method and Apparatus (IJ23)
PO8004 15-Jul-97 Image Creation Method and Apparatus (IJ26) PO8037 15-Jul-97 Image Creation Method and Apparatus (IJ27)	PO8039	15-Jul-97	Image Creation Method and Apparatus (IJ24)
PO8037 15-Jul-97 Image Creation Method and Apparatus (IJ27)	PO8041	15-Jul-97	Image Creation Method and Apparatus (IJ25)
	PO8004	15-Jul-97	Image Creation Method and Apparatus (IJ26)
PO8043   15-Jul-97   Image Creation Method and Apparatus (IJ28)	PO8037	15-Jul-97	Image Creation Method and Apparatus (IJ27)
	PO8043	15-Jul-97	Image Creation Method and Apparatus (IJ28)

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PO8042	15-Jul-97	Image Creation Method and Apparatus (IJ29)
PO8064	15-Jul-97	Image Creation Method and Apparatus (IJ30)
PO9389	23-Sep-97	Image Creation Method and Apparatus (IJ31)
PO9391	23-Sep-97	Image Creation Method and Apparatus (IJ32)
PP0888	12-Dec-97	Image Creation Method and Apparatus (IJ33)
PP0891	12-Dec-97	Image Creation Method and Apparatus (IJ34)
PP0890	12-Dec-97	Image Creation Method and Apparatus (IJ35)
PP0873	12-Dec-97	Image Creation Method and Apparatus (IJ36)
PP0993	12-Dec-97	Image Creation Method and Apparatus (IJ37)
PP0890	12-Dec-97	Image Creation Method and Apparatus (IJ38)
PP1398	19-Jan-98	An Image Creation Method and Apparatus (IJ39)
PP2592	25-Mar-98	An Image Creation Method and Apparatus (IJ40)
PP2593	25-Mar-98	Image Creation Method and Apparatus (IJ41)
PP3991	9-Jun-98	Image Creation Method and Apparatus (IJ42)
PP3987	9-Jun-98	Image Creation Method and Apparatus (IJ43)
PP3985	9-Jun-98	Image Creation Method and Apparatus (IJ44)
PP3983	9-Jun-98	Image Creation Method and Apparatus (IJ45)

# Ink Jet Manufacturing

Further, the present application may utilize advanced semiconductor fabrication techniques in the construction of large arrays of ink jet printers. Suitable manufacturing techniques are described in the following Australian provisional patent specifications incorporated here by cross-reference:

Australian Provisiona Number	Filing Date	Title
PO7935	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM01)
PO7936	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM02)
PO7937	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM03)
PO8061	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM04)
PO8054	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM05)
PO8065	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM06)

PO8055	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus
PO8053	15-Jul-97	(IJM07) A Method of Manufacture of an Image Creation Apparatus
		(IJM08)
PO8078	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM09)
PO7933	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM10)
PO7950	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM11)
PO7949	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM12)
PO8060	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM13)
PO8059	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM14)
PO8073	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM15)
PO8076	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM16)
PO8075	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM17)
PO8079	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM18)
PO8050	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM19)
PO8052	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM20)
PO7948	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM21)
PO7951	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM22)
PO8074	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM23)
PO7941	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM24)
PO8077	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM25)
PO8058	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM26)
PO8051	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM27)

PO8045	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM28)
PO7952	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM29)
PO8046	15-Jul-97	A Method of Manufacture of an Image Creation Apparatus (IJM30)
PO8503	11-Aug-97	A Method of Manufacture of an Image Creation Apparatus (IJM30a)
PO9390		A Method of Manufacture of an Image Creation Apparatus (IJM31)
PO9392	23-Sep-97	A Method of Manufacture of an Image Creation Apparatus (IJM32)
PP0889	12-Dec-97	A Method of Manufacture of an Image Creation Apparatus (IJM35)
PP0887	12-Dec-97	A Method of Manufacture of an Image Creation Apparatus (IJM36)
PP0882	12-Dec-97	A Method of Manufacture of an Image Creation Apparatus (IJM37)
PP0874	12-Dec-97	A Method of Manufacture of an Image Creation Apparatus (IJM38)
PP1396	19-Jan-98	A Method of Manufacture of an Image Creation Apparatus (IJM39)
PP2591	25-Mar-98	A Method of Manufacture of an Image Creation Apparatus (IJM41)
PP3989	9-Jun-98	A Method of Manufacture of an Image Creation Apparatus (IJM40)
PP3990	9-Jun-98	A Method of Manufacture of an Image Creation Apparatus (IJM42)
PP3986	9-Jun-98	A Method of Manufacture of an Image Creation Apparatus (IJM43)
PP3984	9-Jun-98	A Method of Manufacture of an Image Creation Apparatus (IJM44)
PP3982	9-Jun-98	A Method of Manufacture of an Image Creation Apparatus (IJM45)

### Fluid Supply

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Further, the present application may utilize an ink delivery system to the ink jet head. Delivery systems relating to the supply of ink to a series of ink jet nozzles are described in the following Australian provisional patent specifications, the disclosure of which are hereby incorporated by cross-reference:

Australian Provisional Number	Filing Date	Title
PO8003	15-Jul-97	Supply Method and Apparatus (F1)
PO8005	15-Jul-97	Supply Method and Apparatus (F2)
PO9404	23-Sep-97	A Device and Method (F3)

## **MEMS Technology**

Further, the present application may utilize advanced semiconductor microelectromechanical techniques in the construction of large arrays of ink jet printers. Suitable microelectromechanical techniques are described in the following Australian provisional patent specifications incorporated here by cross-reference:

Australian Provisional Number	Filing Date	Title
PO7943	15-Jul-97	A device (MEMS01)
PO8006	15-Jul-97	A device (MEMS02)
PO8007	15-Jul-97	A device (MEMS03)
PO8008	15-Jul-97	A device (MEMS04)
PO8010	15-Jul-97	A device (MEMS05)
PO8011	15-Jul-97	A device (MEMS06)
PO7947	15-Jul-97	A device (MEMS07)
PO7945	15-Jul-97	A device (MEMS08)
PO7944	15-Jul-97	A device (MEMS09)
PO7946	15-Jul-97	A device (MEMS10)
PO9393	23-Sep-97	A Device and Method (MEMS11)
PP0875	12-Dec-97	A Device (MEMS12)
PP0894	12-Dec-97	A Device and Method (MEMS13)

# IR Technologies

Further, the present application may include the utilization of a disposable camera system such as those described in the following Australian provisional patent specifications incorporated here by cross-reference:

Australian Provisional Number	Filing Date	Title
PP0895	12-Dec-97	An Image Creation Method and Apparatus (IR01)
PP0870	12-Dec-97	A Device and Method (IR02)
PP0869	12-Dec-97	A Device and Method (IR04)
PP0887	12-Dec-97	Image Creation Method and Apparatus (IR05)
PP0885	12-Dec-97	An Image Production System (IR06)
PP0884	12-Dec-97	Image Creation Method and Apparatus (IR10)
PP0886	12-Dec-97	Image Creation Method and Apparatus (IR12)
PP0871	12-Dec-97	A Device and Method (IR13)
PP0876	12-Dec-97	An Image Processing Method and Apparatus (IR14)
PP0877	12-Dec-97	A Device and Method (IR16)
PP0878	12-Dec-97	A Device and Method (IR17)
PP0879	12-Dec-97	A Device and Method (IR18)
PP0883	12-Dec-97	A Device and Method (IR19)
PP0880	12-Dec-97	A Device and Method (IR20)
PP0881	12-Dec-97	A Device and Method (IR21)

## **DotCard Technologies**

Further, the present application may include the utilization of a data distribution system such as that described in the following Australian provisional patent specifications incorporated here by cross-reference:

Australian Provisional Number	Filing Date	Title
PP2370	16-Mar-98	Data Processing Method and Apparatus (Dot01)
PP2371	16-Mar-98	Data Processing Method and Apparatus (Dot02)

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# **Artcam Technologies**

Further, the present application may include the utilization of camera and data processing techniques such as an Artcam type device as described in the following Australian provisional patent specifications incorporated here by cross-reference:

Australian Provisional Number	Filing Date	Title
PO7991	15-Jul-97	Image Processing Method and Apparatus (ART01)
PO8505	11-Aug-97	Image Processing Method and Apparatus (ART01a)
PO7988	15-Jul-97	Image Processing Method and Apparatus (ART02)
PO7993	15-Jul-97	Image Processing Method and Apparatus (ART03)
PO8012	15-Jul-97	Image Processing Method and Apparatus (ART05)
PO8017	15-Jul-97	Image Processing Method and Apparatus (ART06)
PO8014	15-Jul-97	Media Device (ART07)
PO8025	15-Jul-97	Image Processing Method and Apparatus (ART08)
PO8032	15-Jul-97	Image Processing Method and Apparatus (ART09)
PO7999	15-Jul-97	Image Processing Method and Apparatus (ART10)
PO7998	15-Jul-97	Image Processing Method and Apparatus (ART11)
PO8031	15-Jul-97	Image Processing Method and Apparatus (ART12)
PO8030	15-Jul-97	Media Device (ART13)
PO8498	11-Aug-97	Image Processing Method and Apparatus (ART14)
PO7997	15-Jul-97	Media Device (ART15)
PO7979	15-Jul-97	Media Device (ART16)
PO8015	15-Jul-97	Media Device (ART17)
PO7978	15-Jul-97	Media Device (ART18)
PO7982	15-Jul-97	Data Processing Method and Apparatus (ART19)
PO7989	15-Jul-97	Data Processing Method and Apparatus (ART20)
PO8019	15-Jul-97	Media Processing Method and Apparatus (ART21)
PO7980	15-Jul-97	Image Processing Method and Apparatus (ART22)
PO7942	15-Jul-97	Image Processing Method and Apparatus (ART23)
PO8018	15-Jul-97	Image Processing Method and Apparatus (ART24)
PO7938	15-Jul-97	Image Processing Method and Apparatus (ART25)
PO8016	15-Jul-97	Image Processing Method and Apparatus (ART26)
PO8024	15-Jul-97	Image Processing Method and Apparatus (ART27)
PO7940	15 <b>-</b> Jul-97	Data Processing Method and Apparatus (ART28)
PO7939	15-Jul-97	Data Processing Method and Apparatus (ART29)
PO8501	11-Aug-97	Image Processing Method and Apparatus (ART30)

